

# **GaNSafe™**

## The World's Safest GaN Power Semiconductor

Corporate Introduction

**David Carroll**

**Sr. VP Worldwide Sales**

**Taipei, September 2023**

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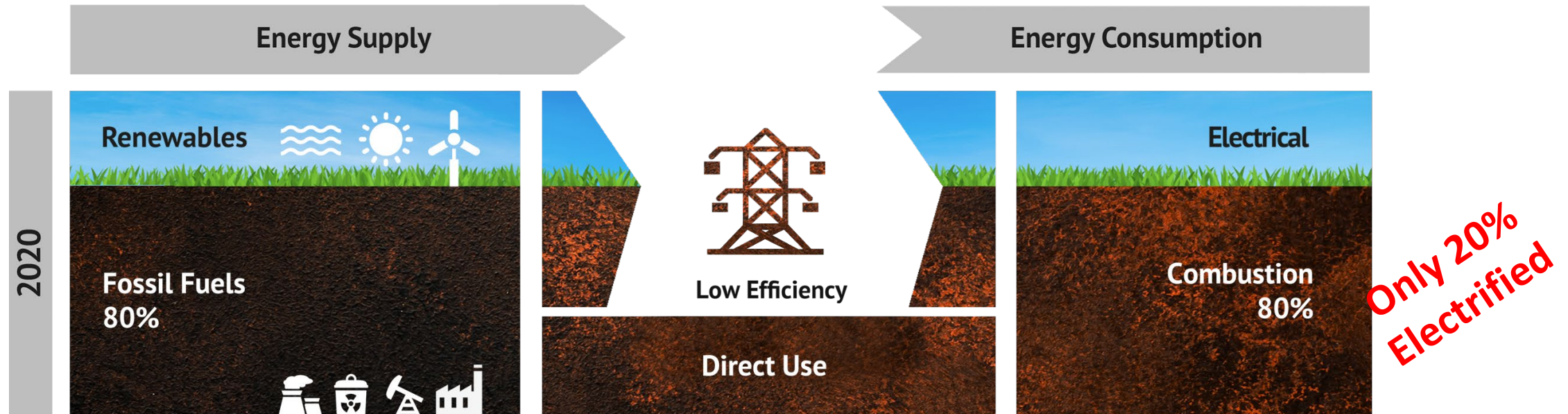
This presentation includes “forward-looking statements” within the meaning of Section 21E of the Securities Exchange Act of 1934, as amended. Forward-looking statements may be identified by the use of words such as “we expect” or “are expected to be,” “estimate,” “plan,” “project,” “forecast,” “intend,” “anticipate,” “believe,” “seek,” or other similar expressions that predict or indicate future events or trends or that are not statements of historical matters. These forward-looking statements include, but are not limited to, statements regarding estimates and forecasts of other financial and performance metrics and projections of market opportunity and market share. These statements are based on various assumptions, whether or not identified in this presentation. These statements are also based on current expectations of our management and are not predictions of actual performance. Such forward-looking statements are provided for illustrative purposes only and are not intended to serve as, and must not be relied on by any investor as, a guarantee, an assurance, a prediction or a definitive statement of fact or probability. Actual events and circumstances are difficult or impossible to predict and will differ from assumptions and expectations. Many actual events and circumstances that affect performance are beyond our control. Forward-looking statements are subject to a number of risks and uncertainties, including the possibility that the expected growth of our business will not be realized, or will not be realized within expected time periods, due to, among other things, the failure to successfully integrate acquired businesses into our business and operational systems; the effect of acquisitions on customer and supplier relationships or the failure to retain and expand those relationships; the success or failure of other business development efforts; our financial condition and results of operations; our ability to accurately predict future revenues for the purpose of appropriately budgeting and adjusting our expenses; our ability to diversify our customer base and develop relationships in new markets; our ability to scale our technology into new markets and applications; our ability to realize our potential pipeline opportunities; the effects of competition on our business, including actions of competitors with an established presence and resources in markets we hope to penetrate, including silicon carbide markets; the level of demand in our customers’ end markets, both generally and with respect to successive generations of products or technology; our ability to attract, train and retain key qualified personnel; changes in government trade policies, including the imposition of tariffs; the impact of the COVID-19 pandemic on our business, results of operations and financial condition; the impact of the COVID-19 pandemic on the global economy, including but not limited to our supply chain and the supply chains of customers and suppliers; regulatory developments in the United States and foreign countries; and our ability to protect our intellectual property rights. These and other risk factors are discussed in the Risk Factors section beginning on p. 15 of our annual report on Form 10-K for the year ended December 31, 2022, which we filed with the Securities and Exchange Commission (the “SEC”) on April 3, 2022 and as thereafter amended, and in other documents we file with the SEC, including our quarterly reports on Form 10-Q. If any of these risks materialize or our assumptions prove incorrect, actual results could differ materially from the results implied by these forward-looking statements. There may be additional risks that we are not aware of or that we currently believe are immaterial that could also cause actual results to differ materially from those contained in the forward-looking statements. In addition, forward-looking statements reflect our expectations, plans or forecasts of future events and views as of the date of this presentation. We anticipate that subsequent events and developments will cause our assessments to change. However, while we may elect to update these forward-looking statements at some point in the future, we specifically disclaim any obligation to do so. These forward-looking statements should not be relied upon as representing our assessments as of any date subsequent to the date of this presentation.

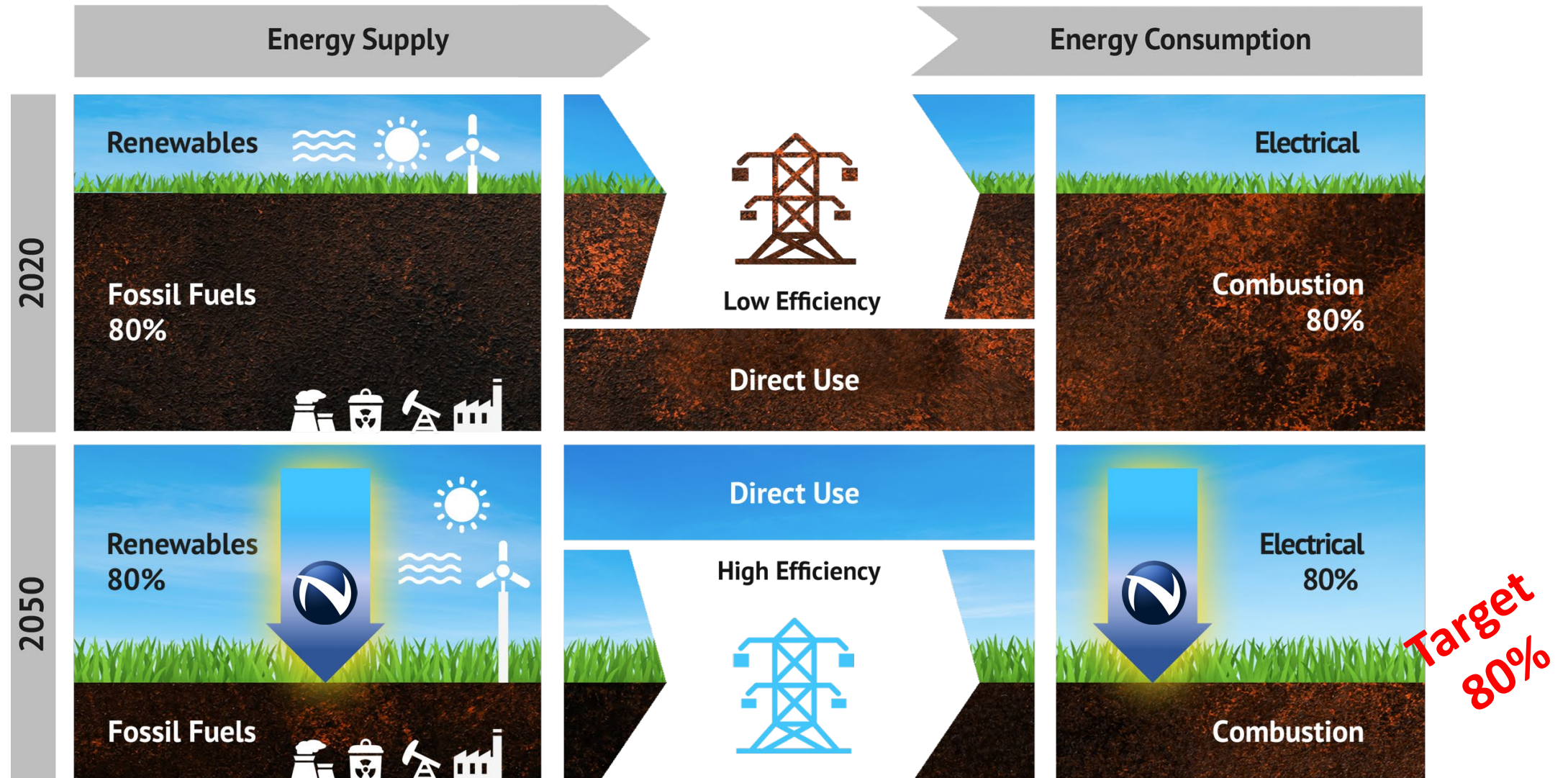
This presentation also contains estimates and other statistical data made by independent parties and by us relating to market size and growth and other data about our industry. This data involves a number of assumptions and limitations, and you are cautioned not to give undue weight to such estimates. Neither we nor any other person makes any representation as to the accuracy or completeness of such data or undertakes any obligation to update such data after the date of this presentation. In addition, projections, assumptions and estimates of our future performance and the future performance of the markets in which we operate are necessarily subject to a high degree of uncertainty and risk.

For further information with respect to our company, we refer you to our most recent annual report on Form 10-K and our most recent quarterly report on Form 10-Q, filed with the SEC. In addition, we are subject to the information and reporting requirements of the Securities Exchange Act of 1934, as amended, and, accordingly, we file periodic reports, current reports, proxy statements and other information with the SEC. These periodic reports, current reports, proxy statements and other information are available for review at the SEC’s website at <http://www.sec.gov>.

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**GaNFast™**

**GeneSiC™**



Up to  
**20x**

**Faster  
Switching<sup>(1)</sup>**

Up to  
**3x**

**Smaller &  
Lighter<sup>(1)</sup>**

Up to  
**40%**

**Energy  
Savings<sup>(1)</sup>**

Up to  
**3x**

**Higher  
Power Density<sup>(1)</sup>**

Up to  
**3x**

**Faster  
Charging<sup>(1)</sup>**

Up to  
**25%**

**Lower  
System Cost<sup>(2)</sup>**



**GaN and SiC replacing Si in next-generation  
power applications**

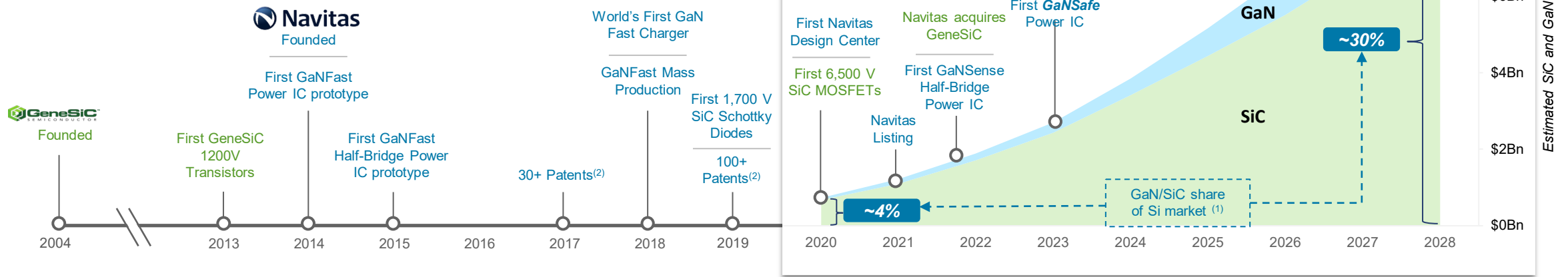
1. Statistical data is based on Navitas estimates of GaN-based systems compared to Si-based estimates in the 2024-2025 timeframe. Based on Navitas measurements of select GaN-based mobile wall chargers compared to Si-based chargers with similar output power, incl. 2019 study of 65W fast chargers, 2022 customer statement re 2.7 kW data center AC-DC
2. Navitas estimates based on customer feedback as the expected system cost saving overtime as of April 2023

# Right Time, Right Technology, Right Company

Technology Development

Validation

Mass Adoption



1. Estimated based on Power SiC/GaN Compound Semiconductor Market Monitor, Q1 2023, Yole Intelligence

2. Granted or pending

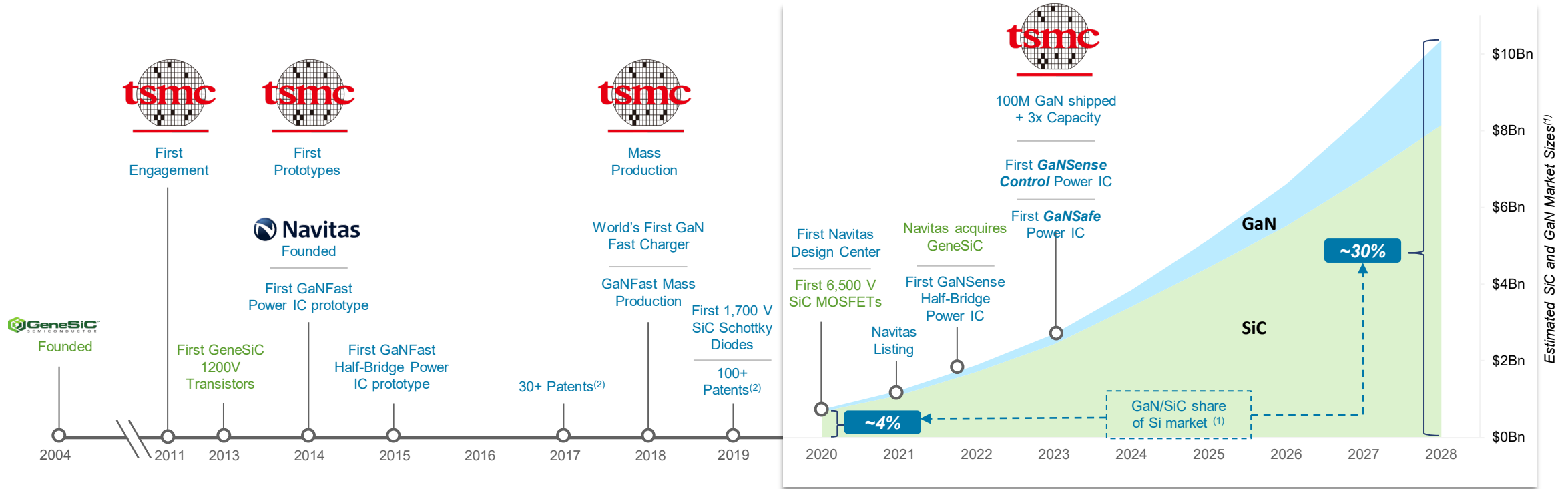


# Right Partnership: Navitas + TSMC

Technology Development

Validation

Mass Adoption



1. Estimated based on Power SiC/GaN Compound Semiconductor Market Monitor, Q1 2023, Yole Intelligence

2. Granted or pending

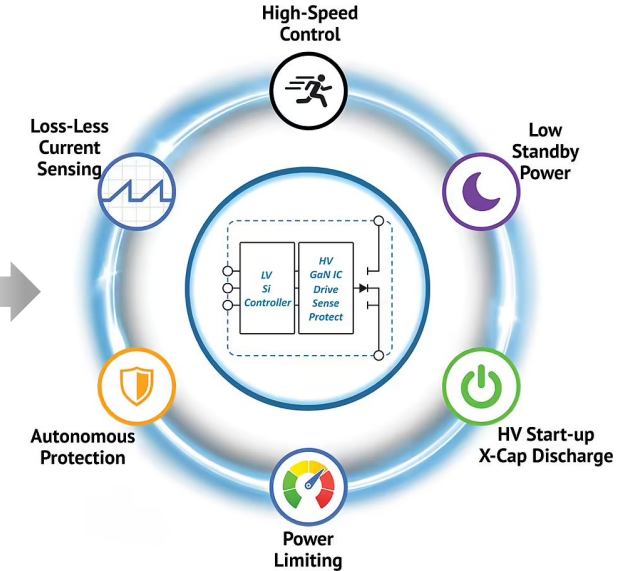
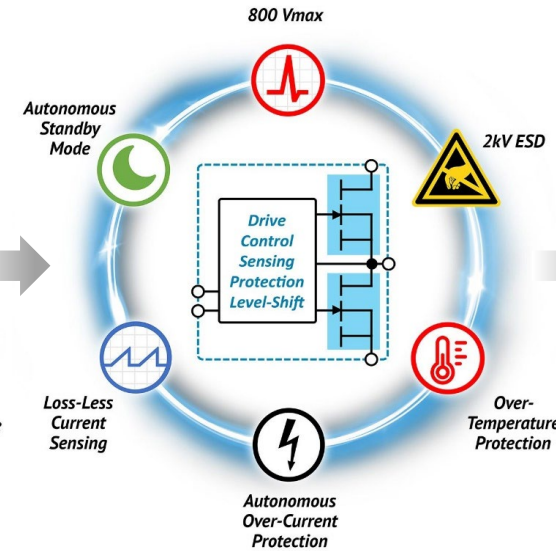
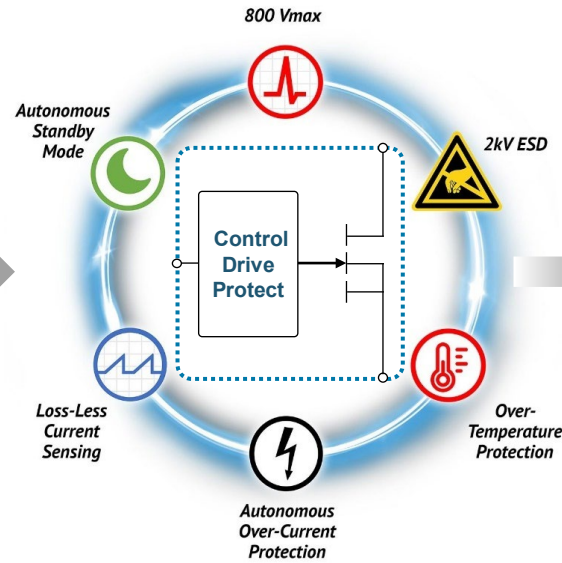
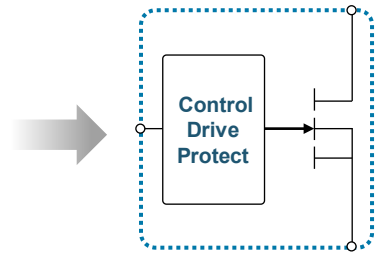
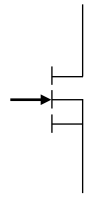
Discrete  
GaN

GaNFast™

GaNSense™

GaNSense  
Half-Bridge

GaNSense  
Control



- Vulnerable
- Difficult to use
- Unknown reliability

- ✓ Robust
- ✓ Easy to use
- ✓ Proven reliability

- GaNFast plus:**
- ✓ Autonomous protection
  - ✓ Loss-less current sensing

- GaNSense plus:**
- ✓ Integrated HS, LS, level-shift isolation
  - ✓ Complete protection

- GaNSense plus:**
- ✓ LV silicon system controller
  - ✓ Fewest components

Efficiency

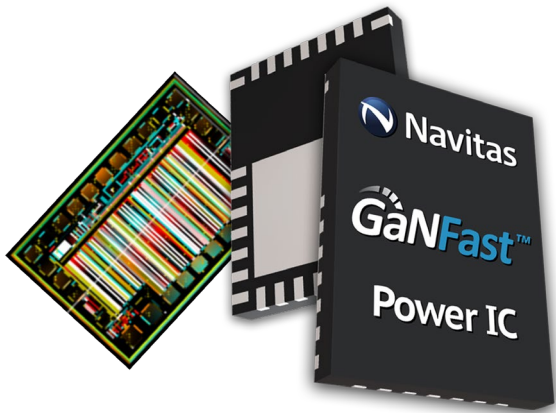
Reliability

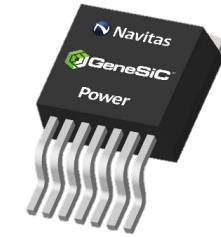
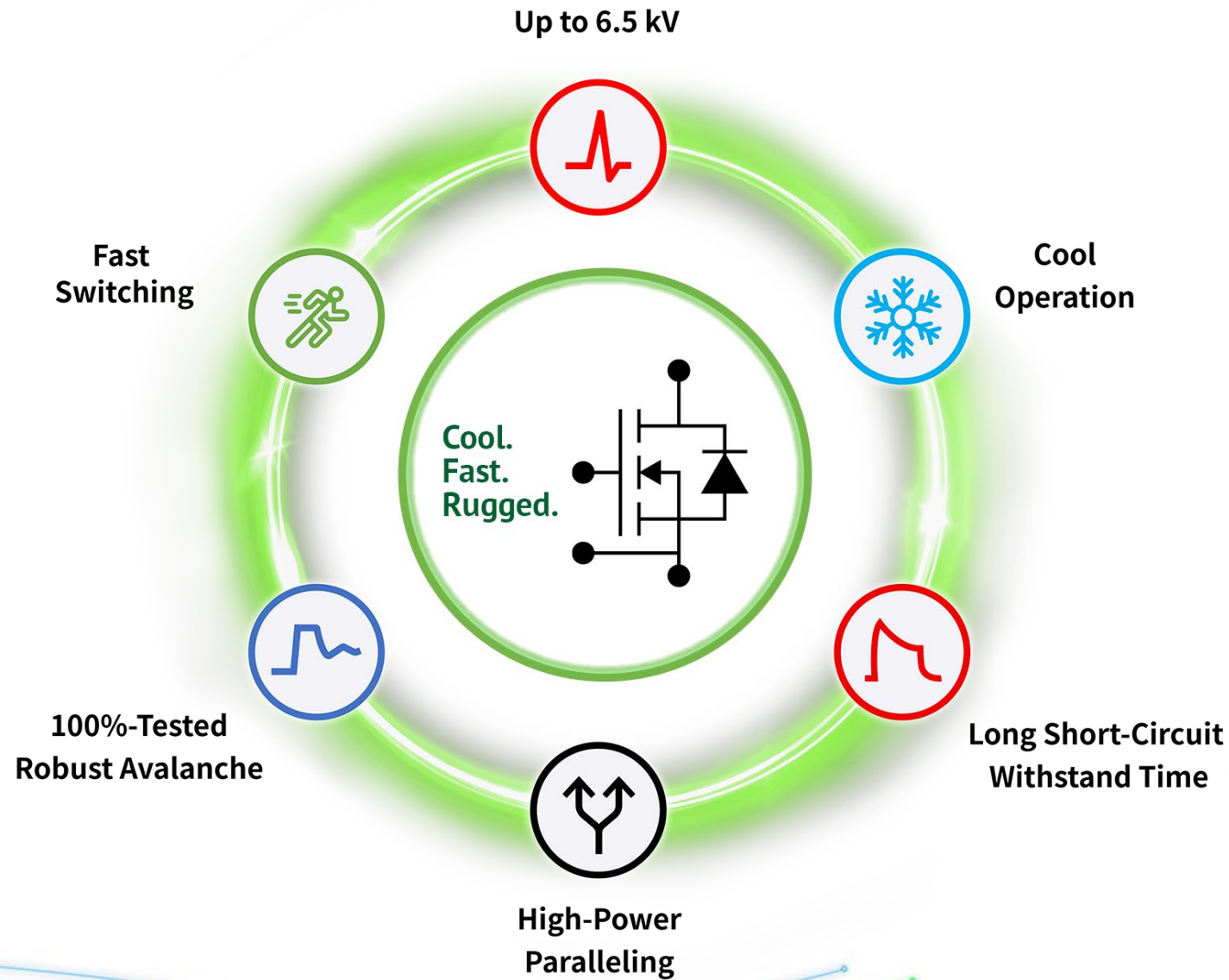
Speed

Integration



***100,000,000+  
Shipped!***



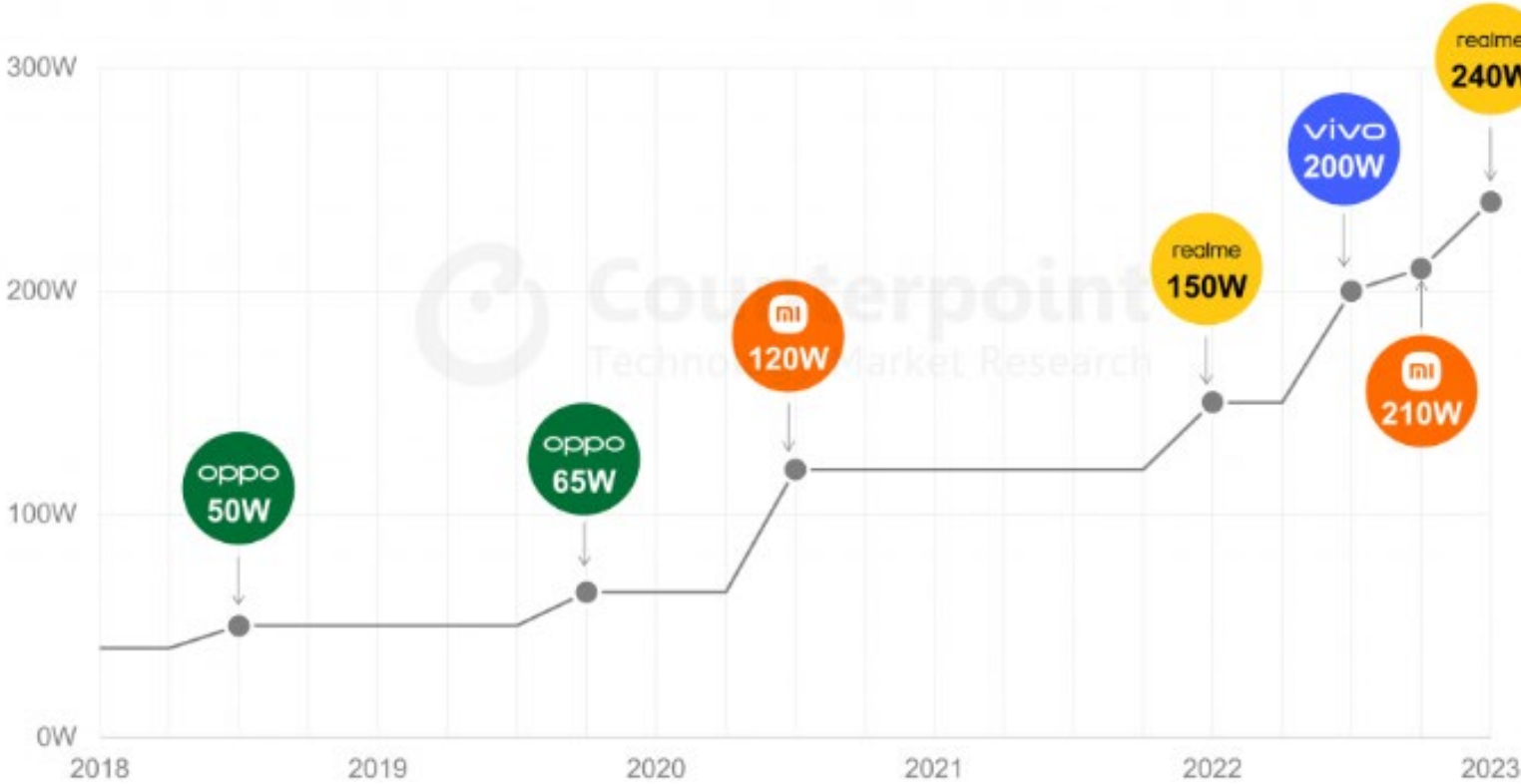




# Accelerating Mobile: Navitas wins 100% Milestones<sup>(1)</sup>



Fast Charger Milestones in Terms of Wattage



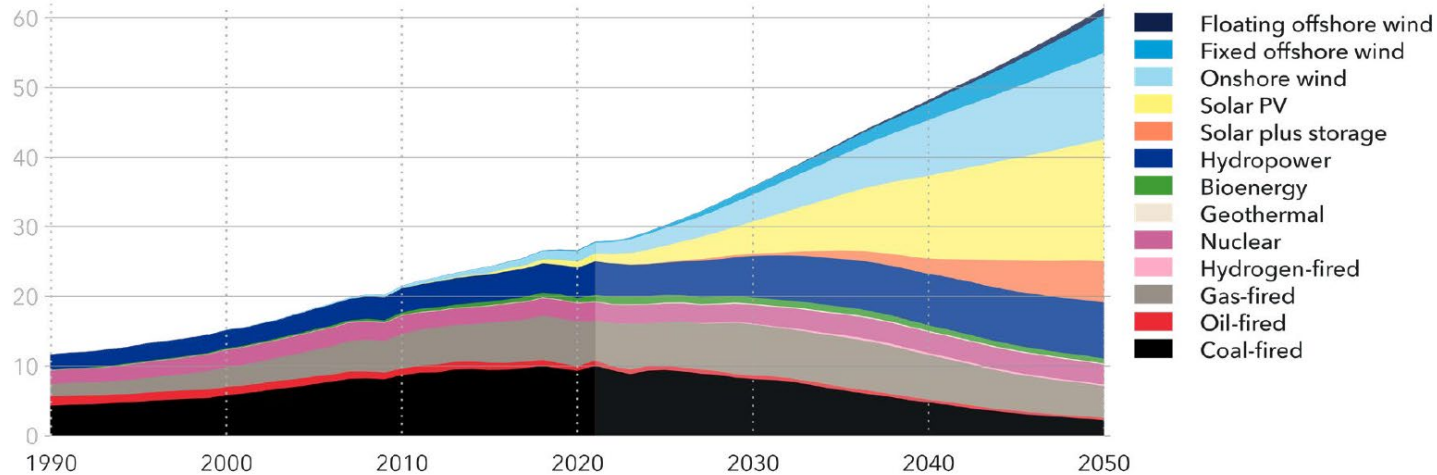
Source: Counterpoint Research



1. Chart from Counterpoint Technology Market Research, published July 2023 (<https://www.counterpointresearch.com/insights/fast-charging-global-smartphone-sales-q1-2023/>). Design wins claim per Navitas press releases.

World grid-connected electricity generation by power station type<sup>(1)</sup>

Units: PWhr/year



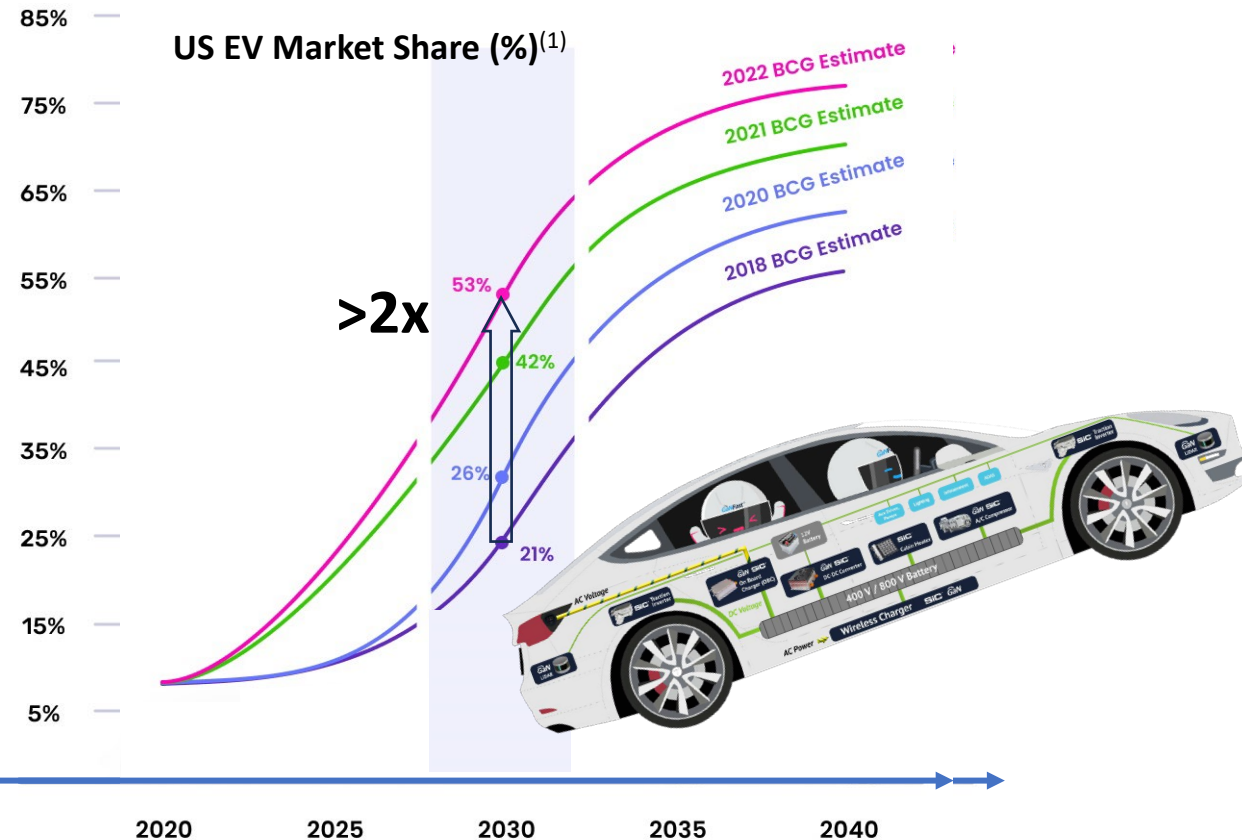
- Global electricity supply +2.3x by 2050<sup>(1)</sup>
- Solar / energy-storage systems (ESS) up from ~2% to 38%<sup>(2)</sup>
- Energy storage critical to balance supply / demand



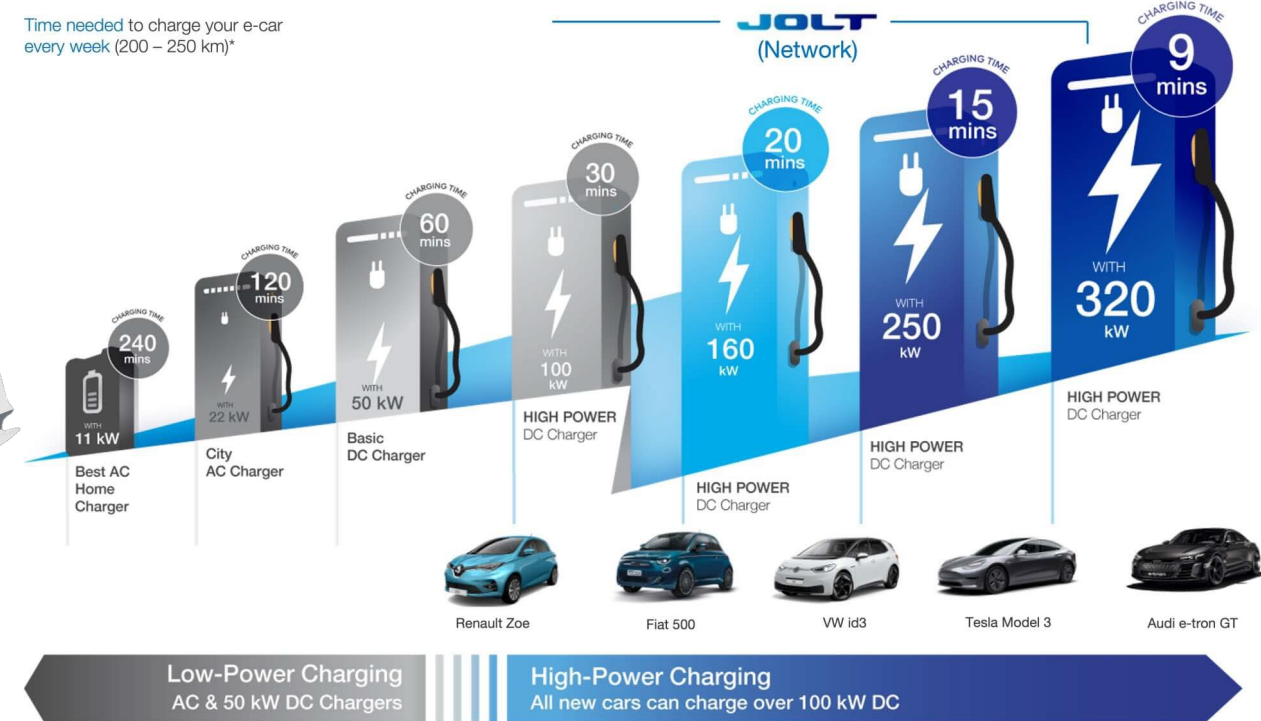
1. DNV Energy Transition Outlook 2022, updated January 2023. Grid-connected energy supply estimated to increase from 27 to 62 PWhr/year.

2. DNV: Solar/ESS grows to 38% of supply by 2050. Historical data per IEA WEB (2022), GlobalData (2022)

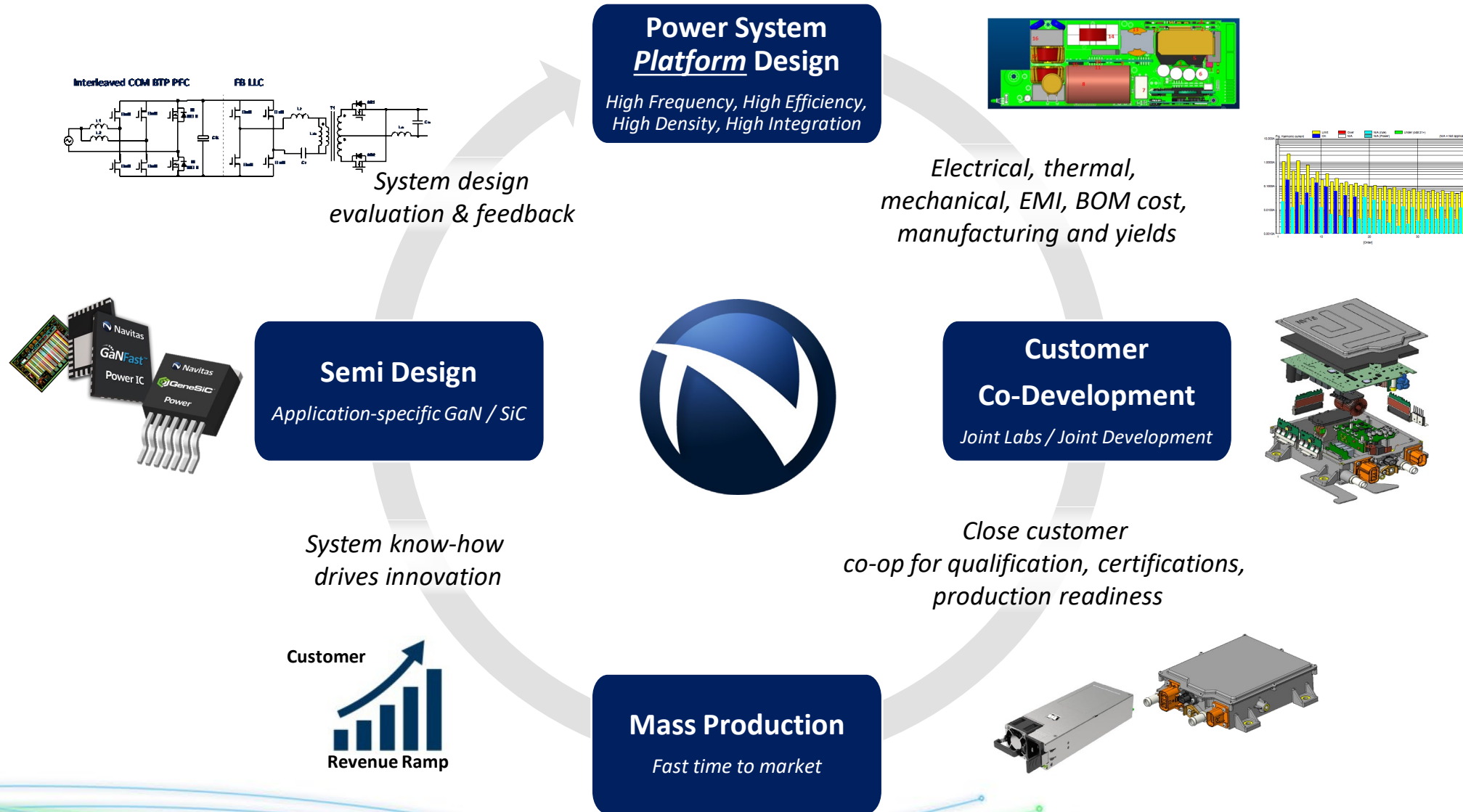




Time needed to charge your e-car every week (200 – 250 km)\*

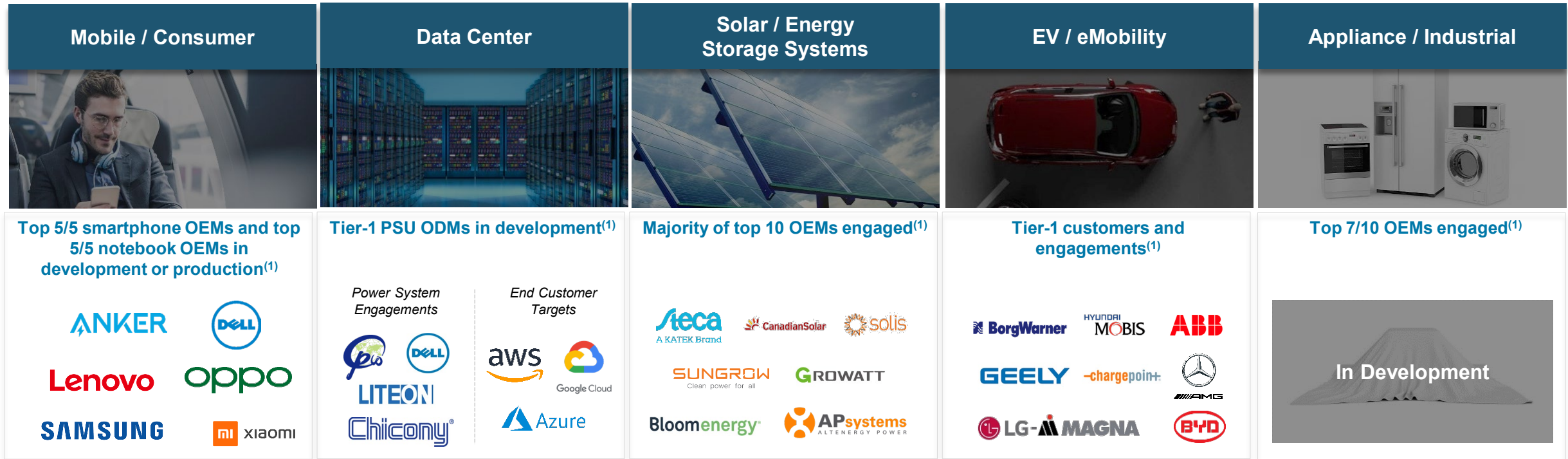


1. Chart BCG, via <https://www.recurrentauto.com/research/ev-adoption-us>  
2. <https://jolt.energy/whats-the-difference-between-ac-dc-and-ultra-fast-charging/>





# Accelerating \$1B<sup>(2)</sup> Customer Pipeline, Diverse markets



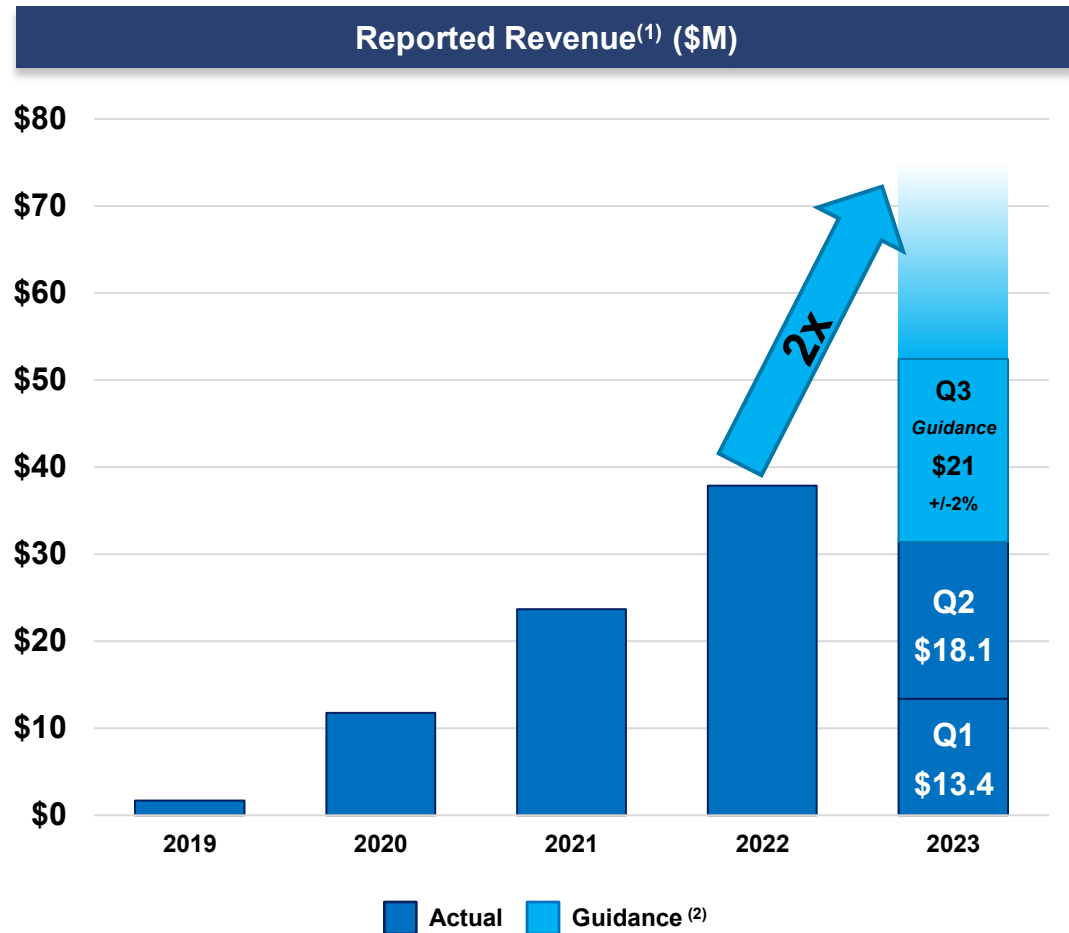
- Q2 2023: Pipeline up 30% to \$1 billion, with more projects, more \$ potential in all markets

1. Navitas estimates of top OEMs in each respective market and their existing customer engagements. Appliance/Industrial 'top 10' based on Navitas estimate

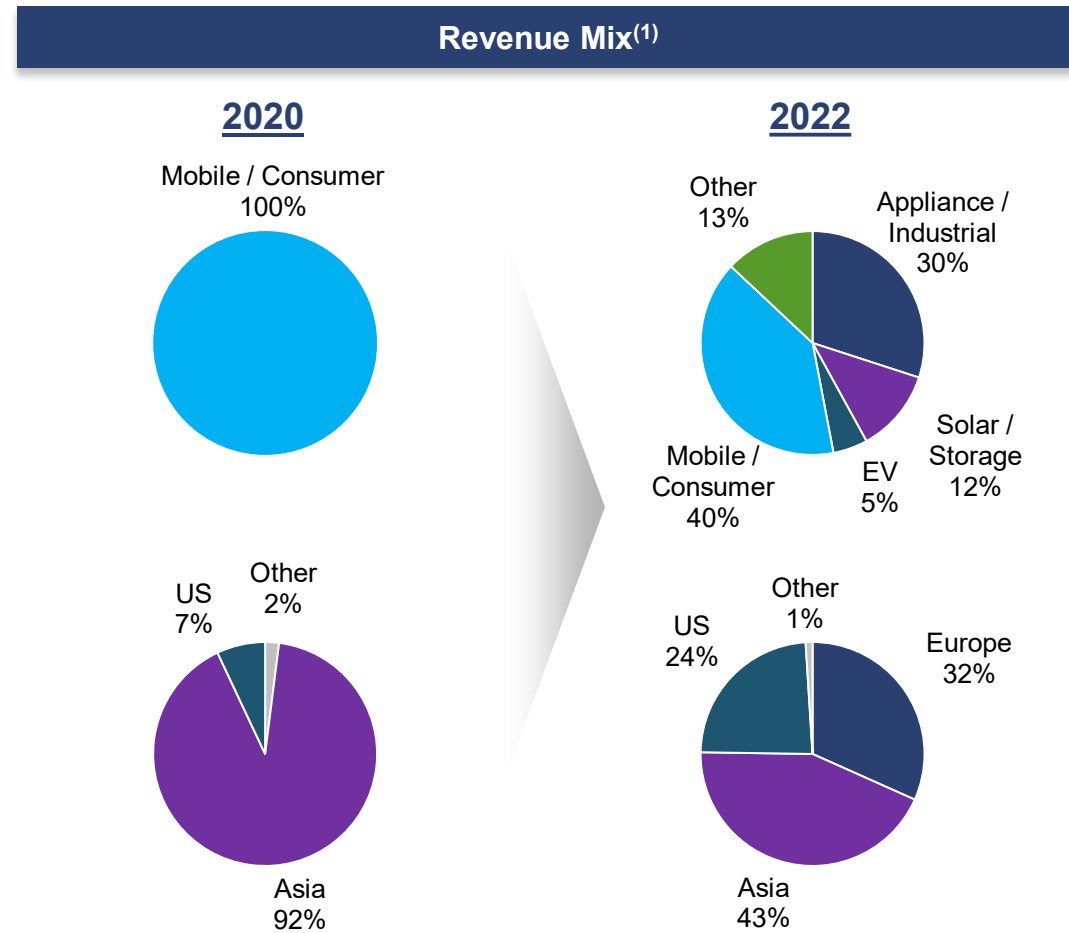
2. "Pipeline opportunity" reflects estimated potential future business based on interest expressed by potential customers for qualified programs, stated in terms of estimated revenue that may be realized in one or more future periods. Pipeline opportunity is not a proxy for backlog or future revenue or other measure or indicator of financial performance. Rather, Navitas uses customer pipeline as a statistical metric to indicate relative changes in future potential business across various product markets. Time horizons vary accordingly, based on product type and application. Actual business realized depends on ultimate customer selection, program share and other factors

3. Navitas estimates for potential customer revenue across GaN or SiC in the market stated

# Accelerating Growth & Diversity



- Q2 '23 revenue +110% from Q2 '22
- Q2 '23 revenue +35% from Q1 '23
- Gross Margin: 41.5%
- Cash: \$177.7M (no debt)
- Shares: 175M



- Significant diversification in markets, geography

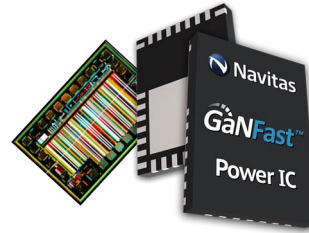
1. Reported revenue not pro forma for GeneSiC financials for the period prior to the close of the acquisition of GeneSiC on 8/15/2022. Only includes GeneSiC revenue for the period post transaction close (8/15/2022 – 12/31/2022)

2. Q3'23 and CY2023 guidance as of 8-14-23 only. Not updated



February '22 First GaN sustainability report based on global standards.

Every **GaNFast™** IC  
saves  
**4 kg CO<sub>2</sub>**



**4x-10x** lower component CO<sub>2</sub> footprint than silicon

**28% lower** lifetime CO<sub>2</sub> footprint for chargers / adapters

**Accelerates** transition from ICE to EV by **3 years**, saving **20%/yr** of road-sector emissions by 2050

GaN + SiC save up to **6 Gton / year** by 2050



May '22 World's first semiconductor company CarbonNeutral® certified



August '22 First 100,000 tons CO<sub>2</sub> saved (Over 170,000 as of August 2023)



October '22 Recognized for industry-leading sustainability reporting



# **GaNSafe™**

## The World's Safest GaN Power Semiconductor

Technology Introduction

**Charles Bailley**

**Sr. Director Business Development**

**Taipei, September 2023**

[ir@navitassemi.com](mailto:ir@navitassemi.com)



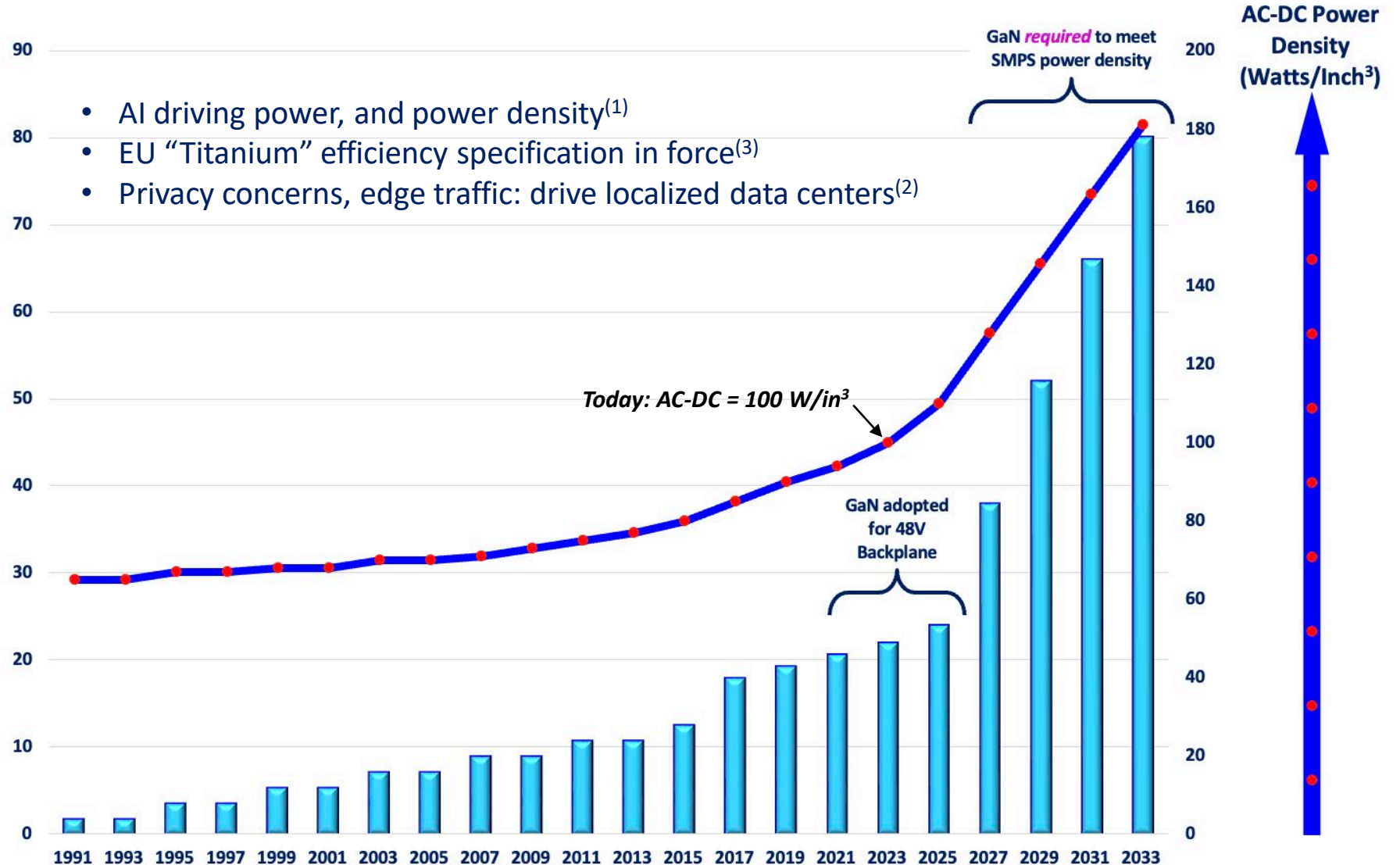
# Accelerating Data Center Power, Efficiency



AUTONOMOUS VEHICLES  
4000GB



Rack Power  
(kWatts)

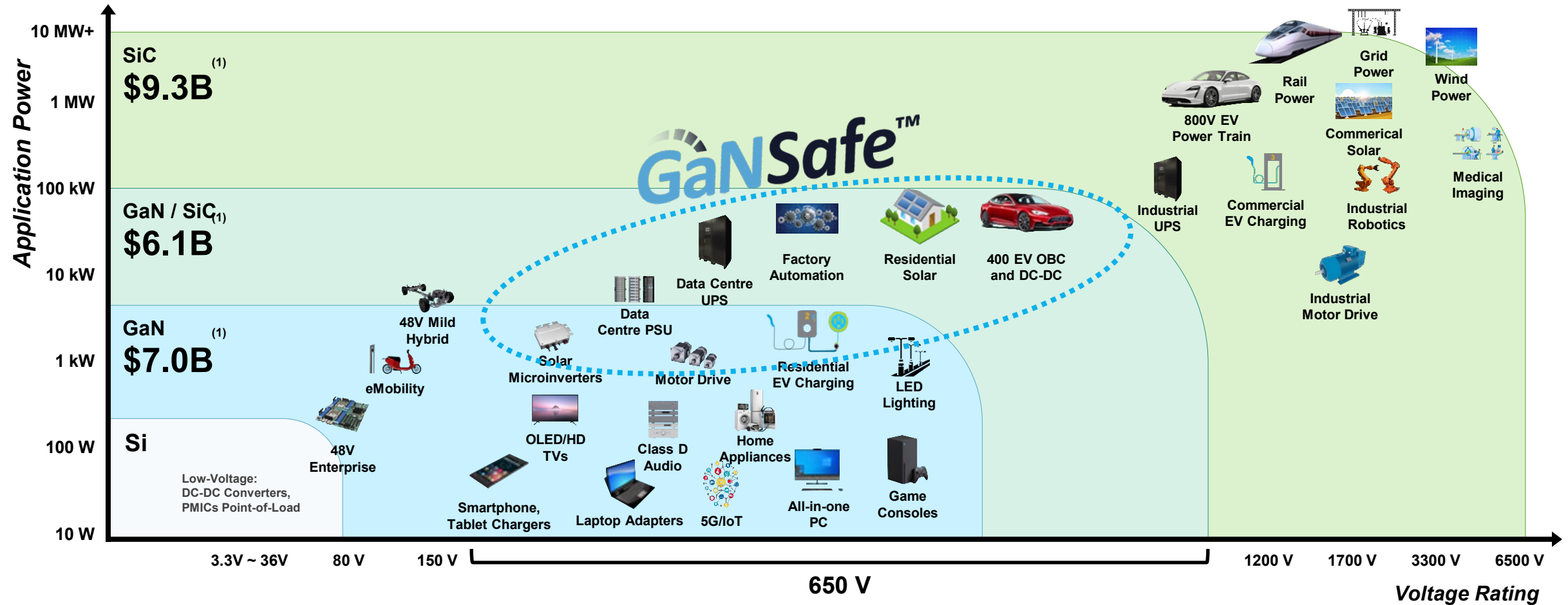


1. Cerebras white paper / website

2. TD Cowen, per “AI to drive data center investments”, LightReading.com, 4-26-23

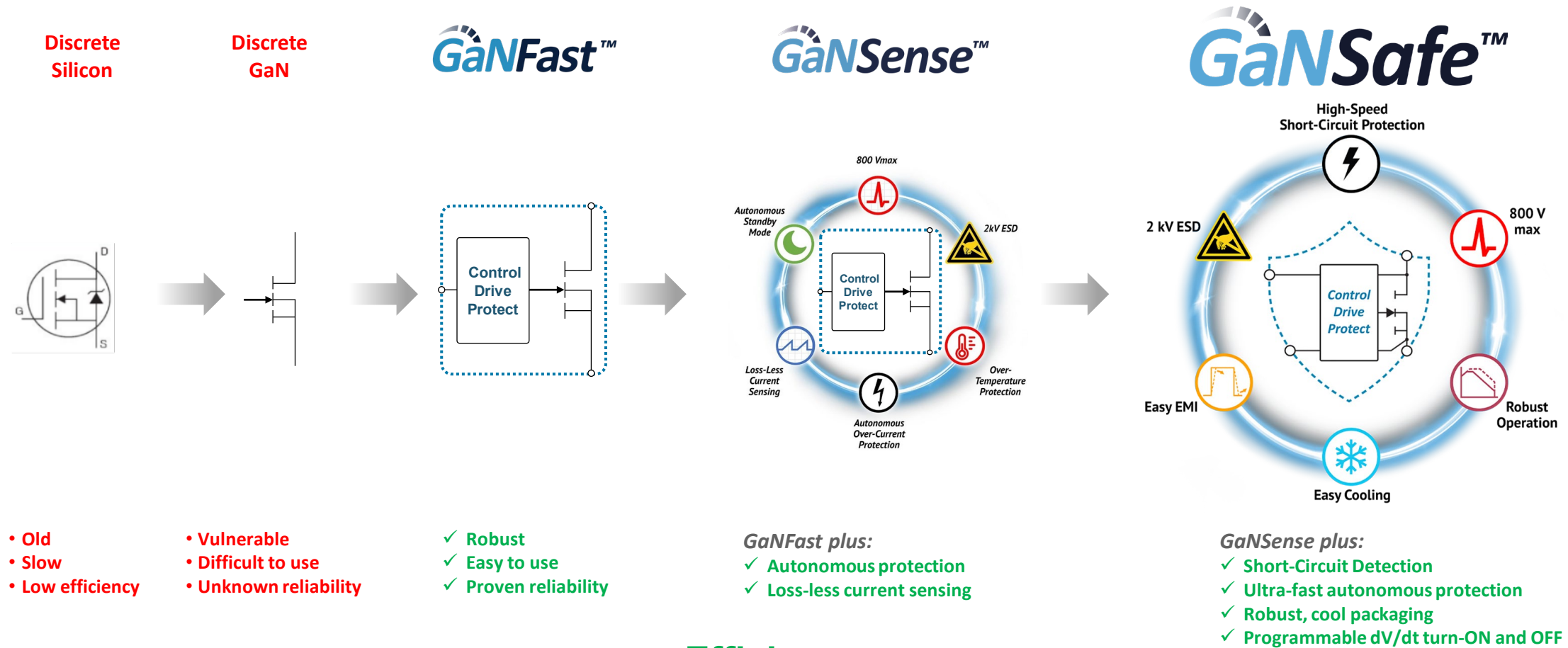
3. European Union ‘Directive 2009/125/EC, 2019 Annex’, power supplies must be >96% efficiency peak, as of 1-1-23

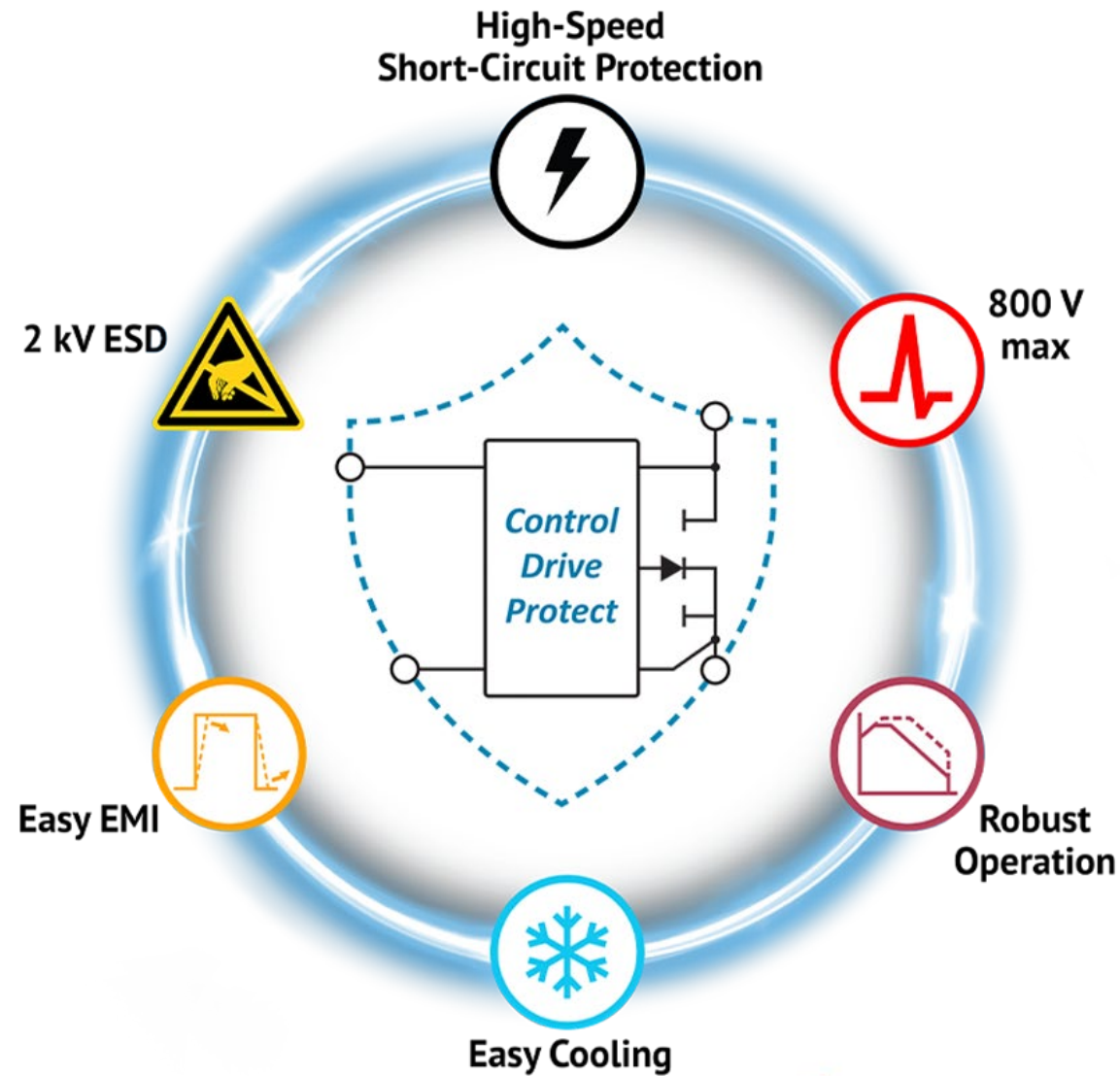
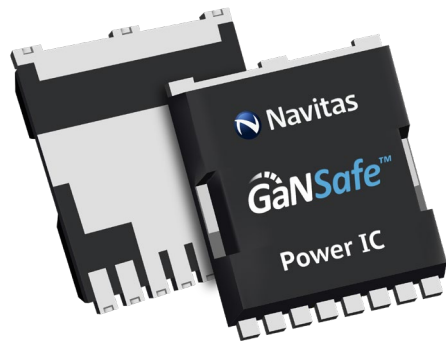


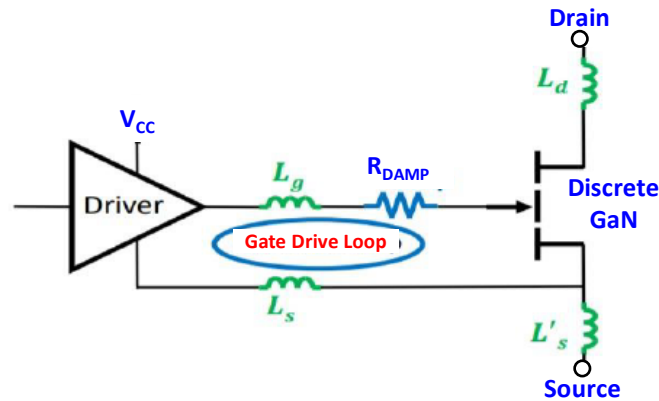


1. Navitas company estimates, potential market opportunity in 2026 is \$22B+ for GaN and SiC, replacing certain of the silicon market share. Axes not to scale

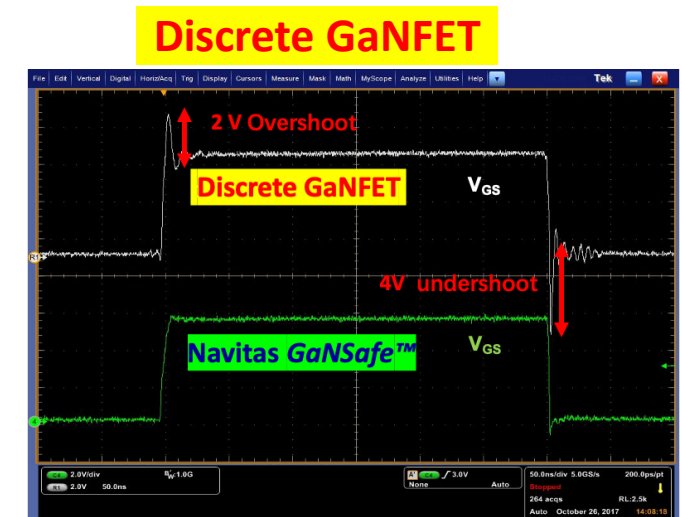
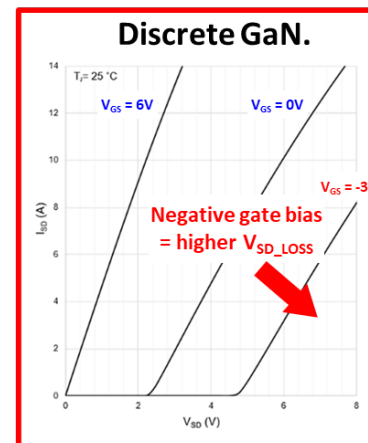
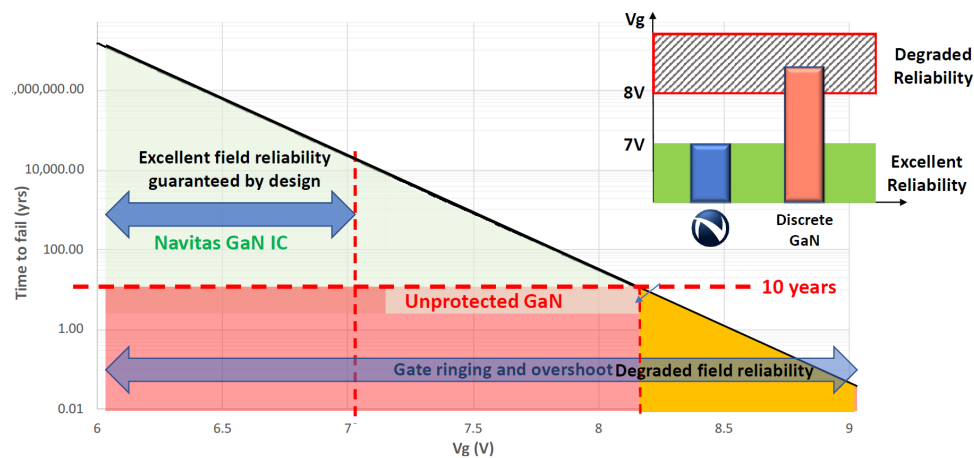




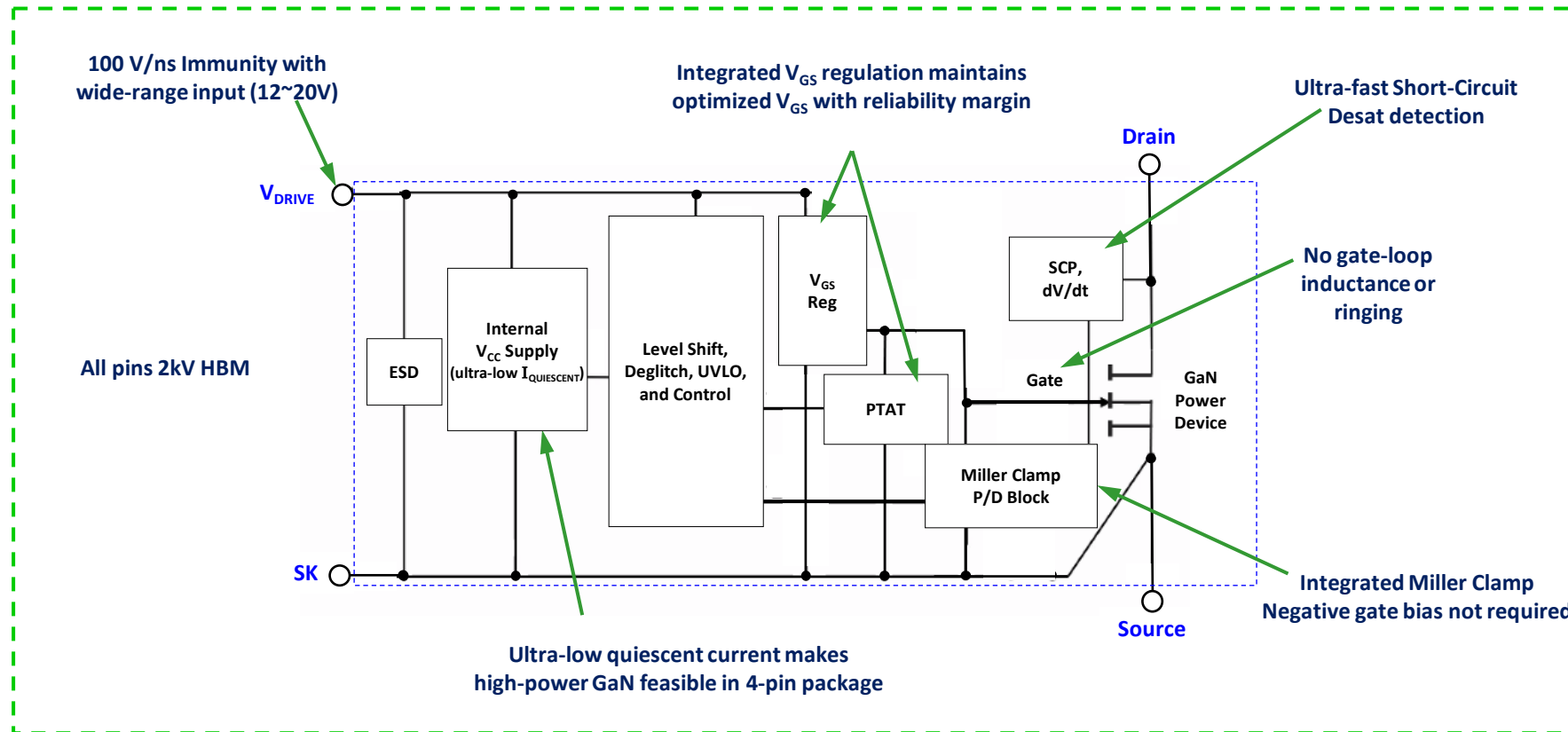




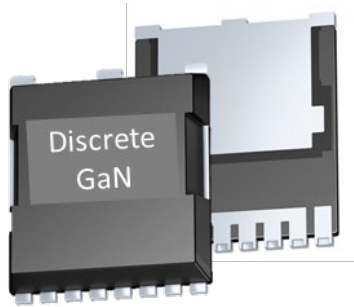
- **Discrete GaN = *high risk***
  - Weak gate, high loop inductance
  - Shoot-thru risk multiplied by increased di/dt in high-power applications
- **GaNFast™** integrated, regulated gate drive, zero loop inductance
  - Fewer components, smaller PCB,
  - Higher efficiency, lower system cost
- **GaNSafe™** optimized for high power
  - More protection (300 ns Desat SCP, OTP, UVLO, ESD, etc.)
  - More control (dV/dt ON & OFF, etc.)
  - Industry-standard, robust, cool packaging





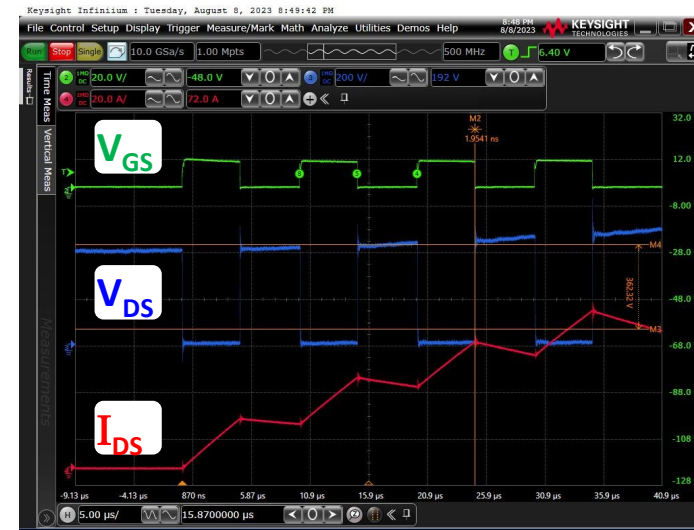


- Double-pulse test:  
400 V, 70 A,  $R_{\text{SERIES}} = 11 \text{ m}\Omega$



**Discrete GaN**  
42 m $\Omega$  max

**Significant spikes**  
**Excessive turn-ON ringing**  
**250 V undershoot**



**GaNSafe™**

45 m $\Omega$  max  
(NV6513)

**No voltage spikes**  
**No ringing**  
**No undershoot**

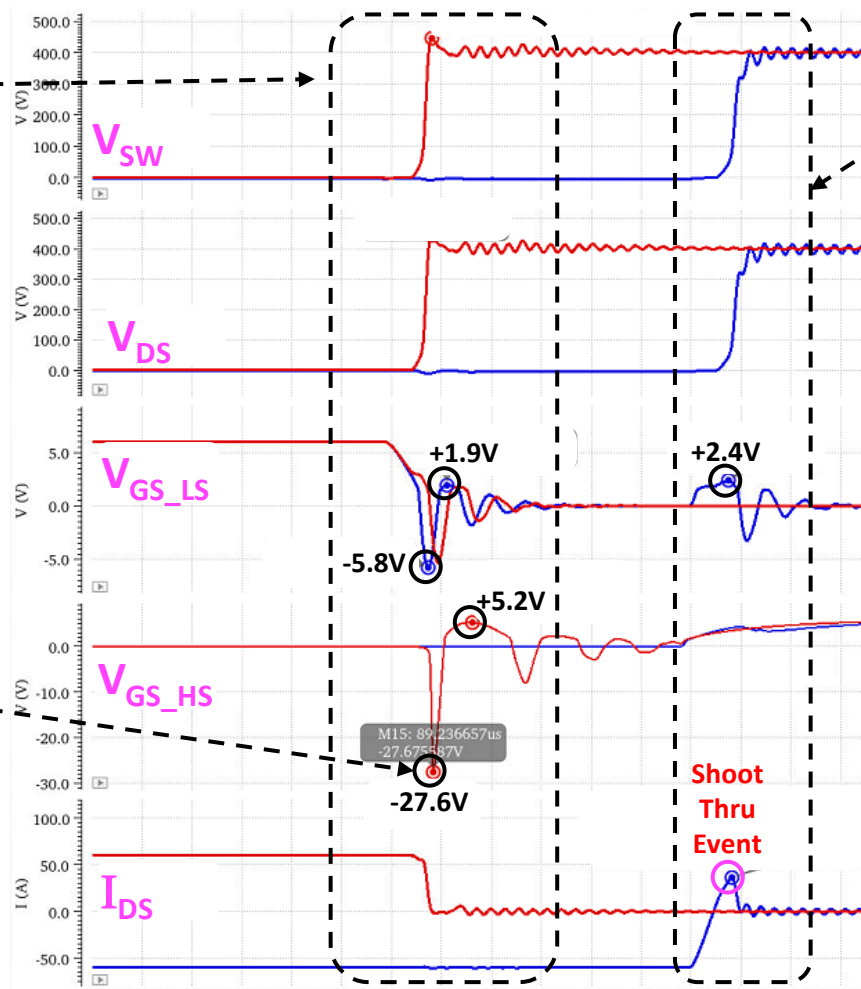
# Discrete GaN Has Major Problems in High Power

## Boost Mode:

LS Turn-OFF causes severe HS & LS  $V_{GS}$  ringing due to gate loop inductance coupled with higher  $di/dt$  when operating in high power applications

## $V_{GS}$ rating violated:

Negative spike on LS Turn-OFF goes beyond -20V limit



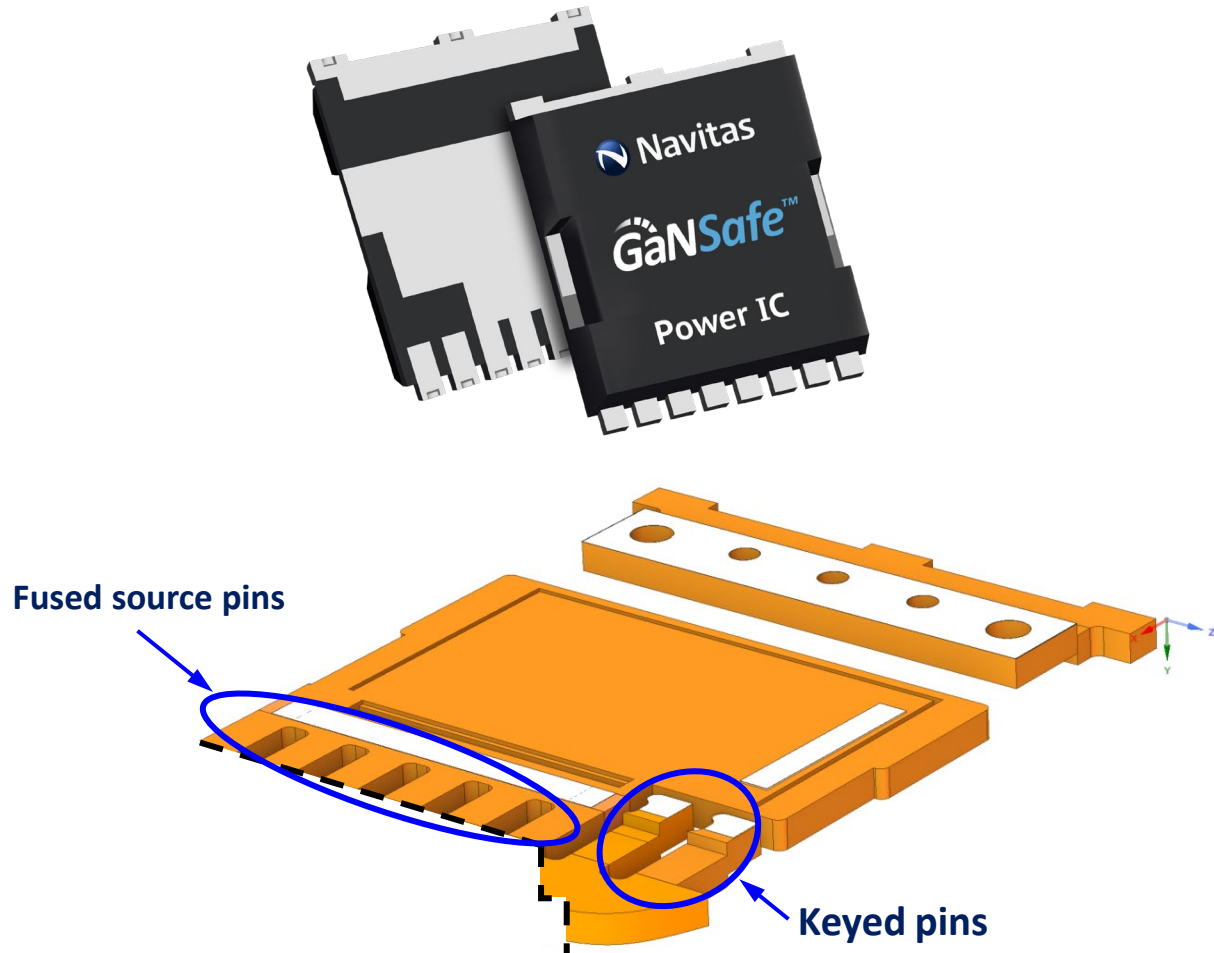
## Buck Mode:

LS gate is pulled-up as Switch Node rises, with simultaneous surge in  $I_{DS}$

## 400V 60A Simulation:

- Discrete GaN
- 25m $\Omega$
- TOLL





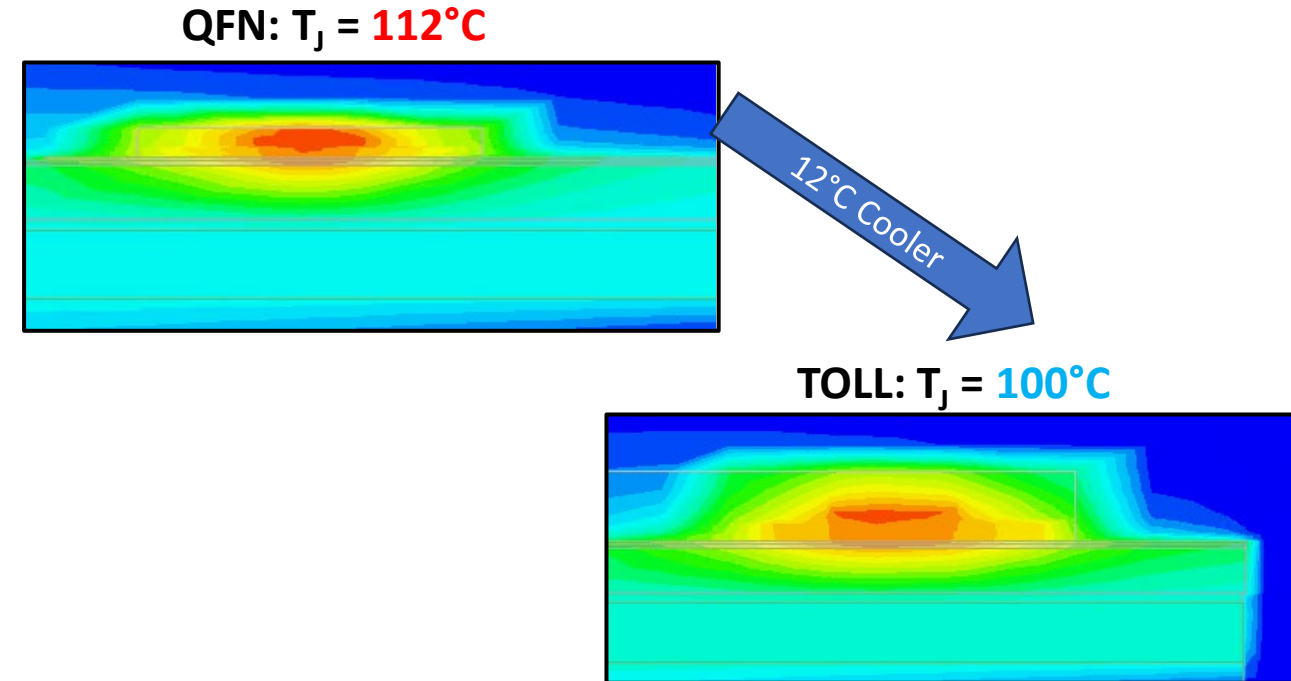
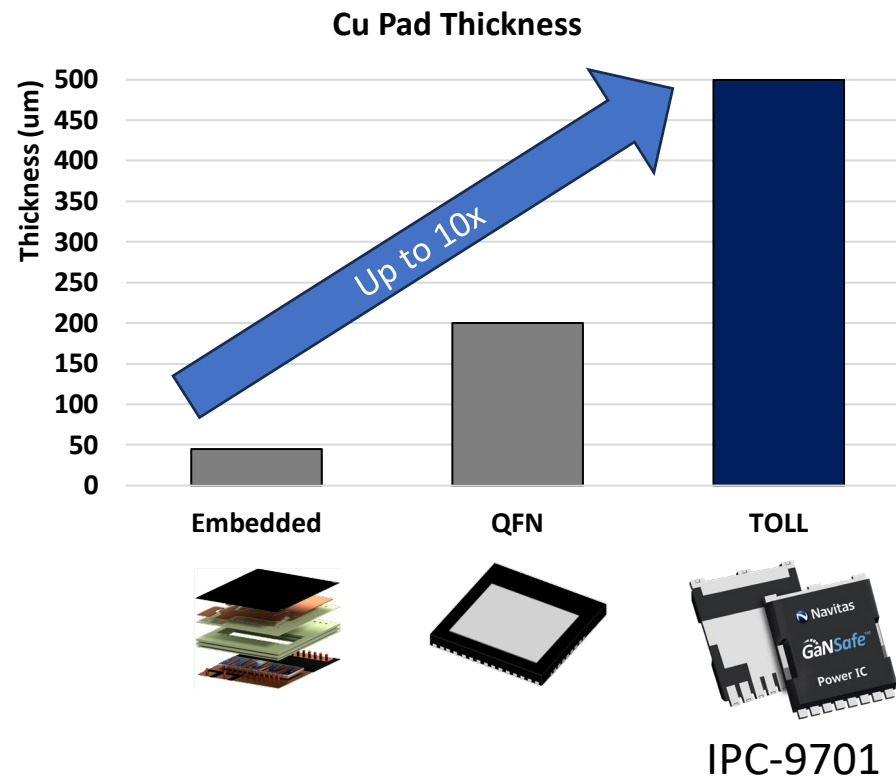
- TOLL = “Transistor Outline Lead-Less”
- 10 x 10 mm
- Mechanically robust, novel leadframe
  - Keyed  $V_{\text{DRIVE}}$  and SK pins
    - Improved mechanical performance
  - Fused source pins
    - Improved thermals)
- Passed IPC-9701 for long mechanical lifetime



## GaNSafe™

Integrated GaN gate drive, protection and features, in 4-pin industry-standard thermally-enhanced package...

1. IPC-9701 “Thermal Cycling Test Method for Fatigue Life Characterization of Surface Mount Attachments”



GaNSafe™

- Optimized, system-level cooling ( $R_{\theta_{J-A}}$ )
  - Larger, thicker Cu pad
  - High-conductivity die attach

1. Navitas' simulated temperature gradients for TOLL and QFN under identical system thermal design and 200 LFM airflow

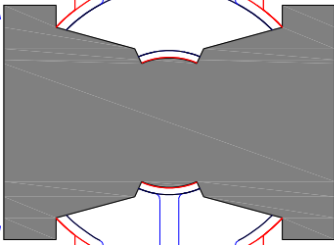
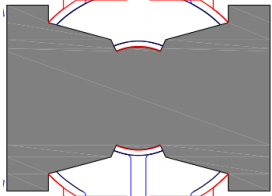
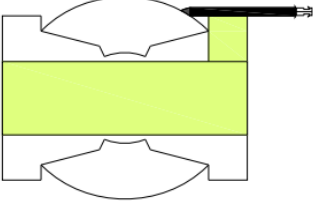
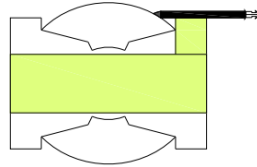






# GaNSafe™ Yields Higher Density, Lower System Cost

**Si 150 kHz LLC**

**3.2 kW**

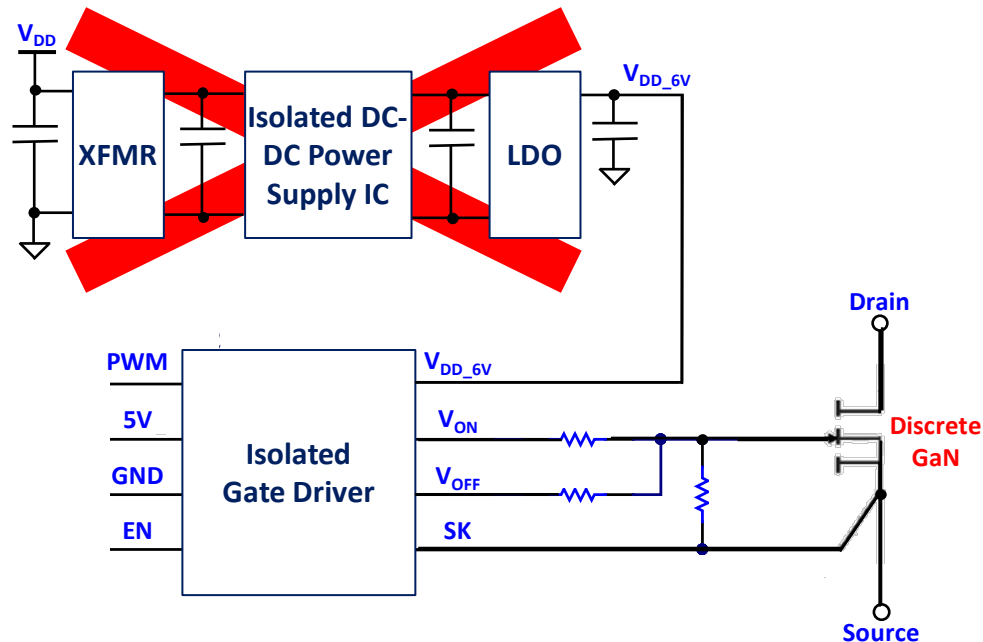
**GaNSafe™**

**300 kHz LLC**

Main Transformer	 <p><b>PQ3628</b> Size: 36 x 28 x 24 mm</p>	→	 <p><b>PQ3033 = 14% smaller</b> Size: 30 x 33 x 21 mm</p>
Resonant Choke	 <p><b>PQ2618:</b> Size: 26 x 18 x 19 mm</p>	→	 <p><b>PQ2018 = 43% smaller</b> Size: 20 x 18 x 14 mm</p>
Resonant Capacitor & Output MLCC	 <p>630 V, 10 nF 1206 *40pcs 16 V, 10 uF 1206 *64pcs</p>	→	 <p>630 V, 10 nF 1206 *<b>12</b>pcs 16 V, 10 uF 1206 *<b>50</b>pcs = 40% fewer</p>
Primary Switch	 <p><b>IPT60R055CFD7 *4pcs</b></p>	→	 <p><b>NV6512C *4pcs</b></p>
Protections & Features	 <p><b>1 kV ESD</b></p>		 <p><b>SCP, 2 kV ESD, dV/dt Control</b></p>





Typical GaN discrete high-side schematic  
for use in high-power applications:

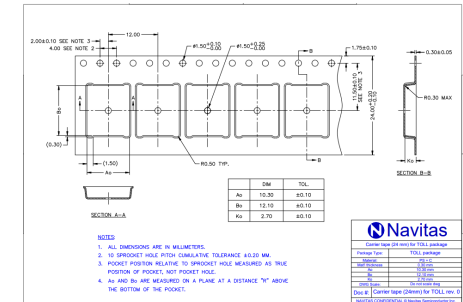


## Eliminate costly DC-DC supply

- **GaNSafe™**
  - Use Boot Strap for high power applications:  
**\$1 saved per half-bridge**
  - Integrated Miller Clamp,  
no negative gate drive ( $V_{GS}$ )
  - Includes SCP protection and 2 kV ESD

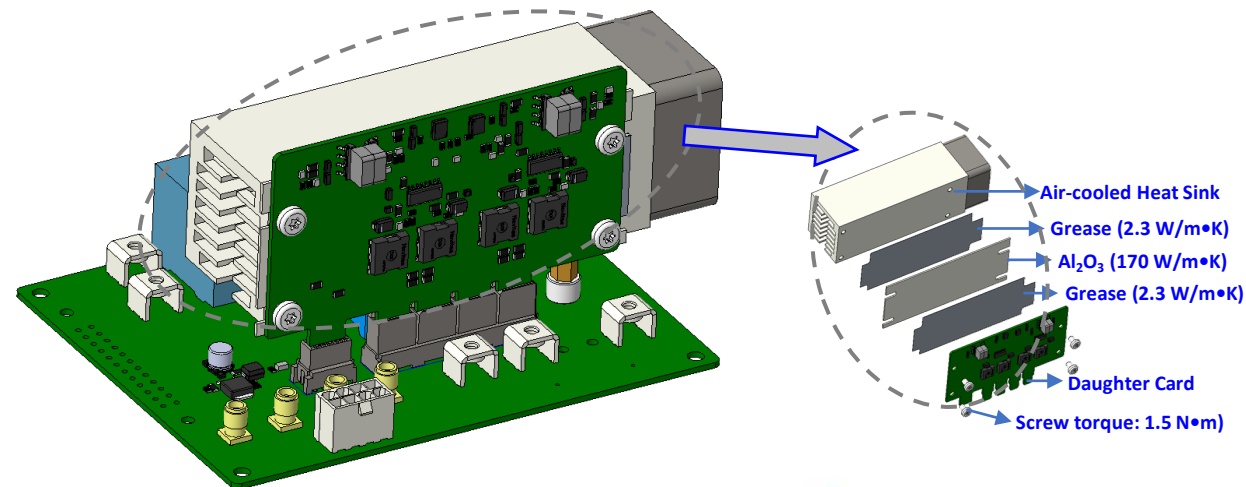
Reference	Type	Robust Package	Minimum Pin-Count	Large Cooling Pad	Easy Cooling (Low R <sub>th</sub> )	Robust High Voltage (V <sub>DS</sub> )	Robust Integrated Gate Drive	Robust Gate Voltage	Over Temp Protection	Short-Circuit Protection	Robust ESD (HBM)	Robust ESD (CDM)	Robust dV/dt	Easy EMI
 GaN Power IC	GaN Power IC	TOLL	4	50 mm <sup>2</sup>	0.36 K/W	800 V	Y	20 V	Y	50 ns	2 kV	1 kV	100 V/ns	(ON,OFF)
Company A	Discrete GaN	TOLL												
B	Discrete GaN	QFN												
C	Discrete GaN	QFN												
D	Discrete GaN	TOLL												
E	Discrete GaN	GaNPX												
F	MCM GaN	High-pin QFN												
G	MCM GaN	High-pin QFN												

Part#	V <sub>DS</sub> (Cont, Max) (V)	V <sub>DS</sub> (Dyn, Max) (V)	R <sub>DS(ON)</sub> (Max 25°C) (mΩ)	I <sub>D</sub> (Max) (A)	Package	Evaluation Kit
NV6515	650	800	35	57	TOLL 10x10 Bottom-cool  	Power Board, Full Bridge Daughter Card, and FanSink/TIM ~ configurable for DPT or Half-Bridge testing
NV6513			45	48		
NV6512			55	34		
NV6511			98	22		



## TnR Ordering

Mini-Reel (7" dia)	Qty500 Pcs "-MR" suffix
Standard (13" dia)	Qty2,000 Pcs



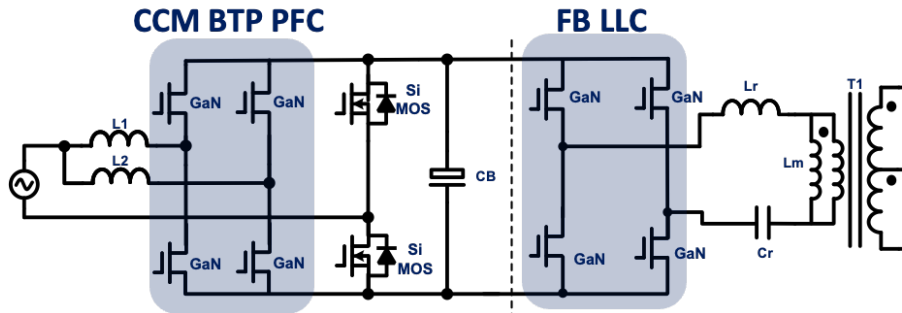
1. Samples and collateral available immediately to qualified customers





# GaNSafe™ : Maximum Performance in Data Center Power



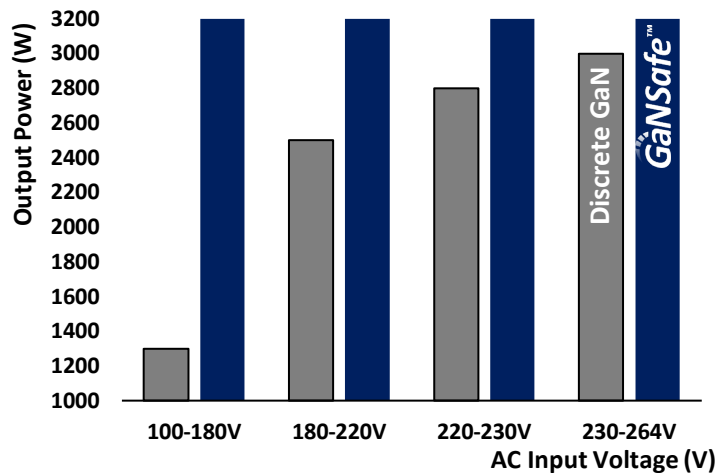
- Data center AC-DC 'silver box' (12V)
- CRPS185 form factor



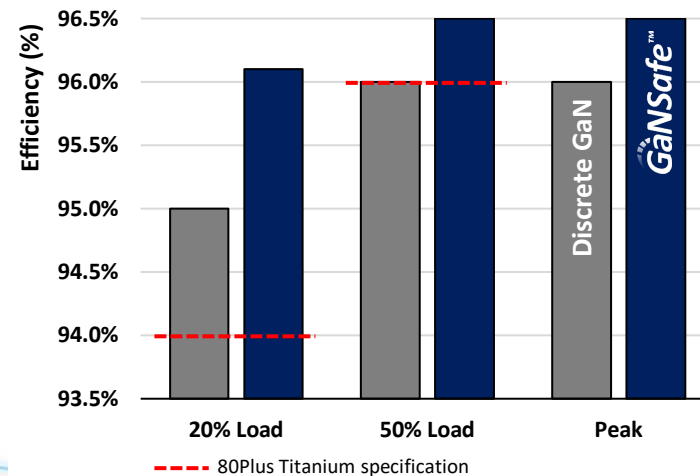
Power	2,800 W	3,200 W
PFC	8 x 32 mΩ	4 x 45 mΩ
DC-DC	4 x 32 mΩ	4 x 55 mΩ
Total	12 x GaNPX 	8 x TOLL 

**GaNSafe™**  
33% fewer  
power  
components

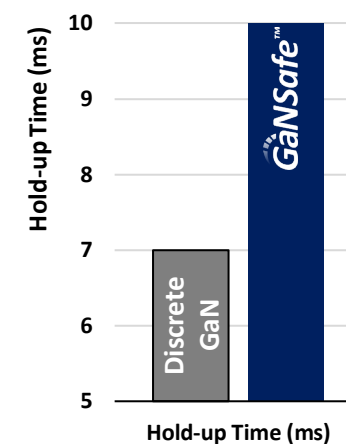
**GaNSafe™ True 3,200W CRPS185**



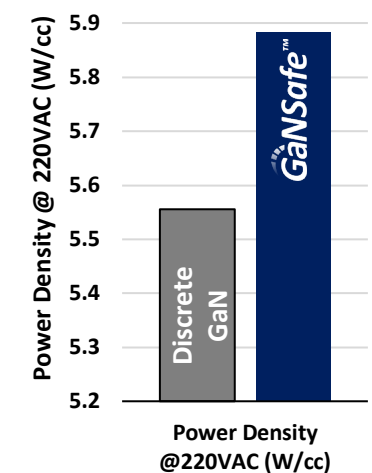
**GaNSafe™ Titanium Plus, with margin**

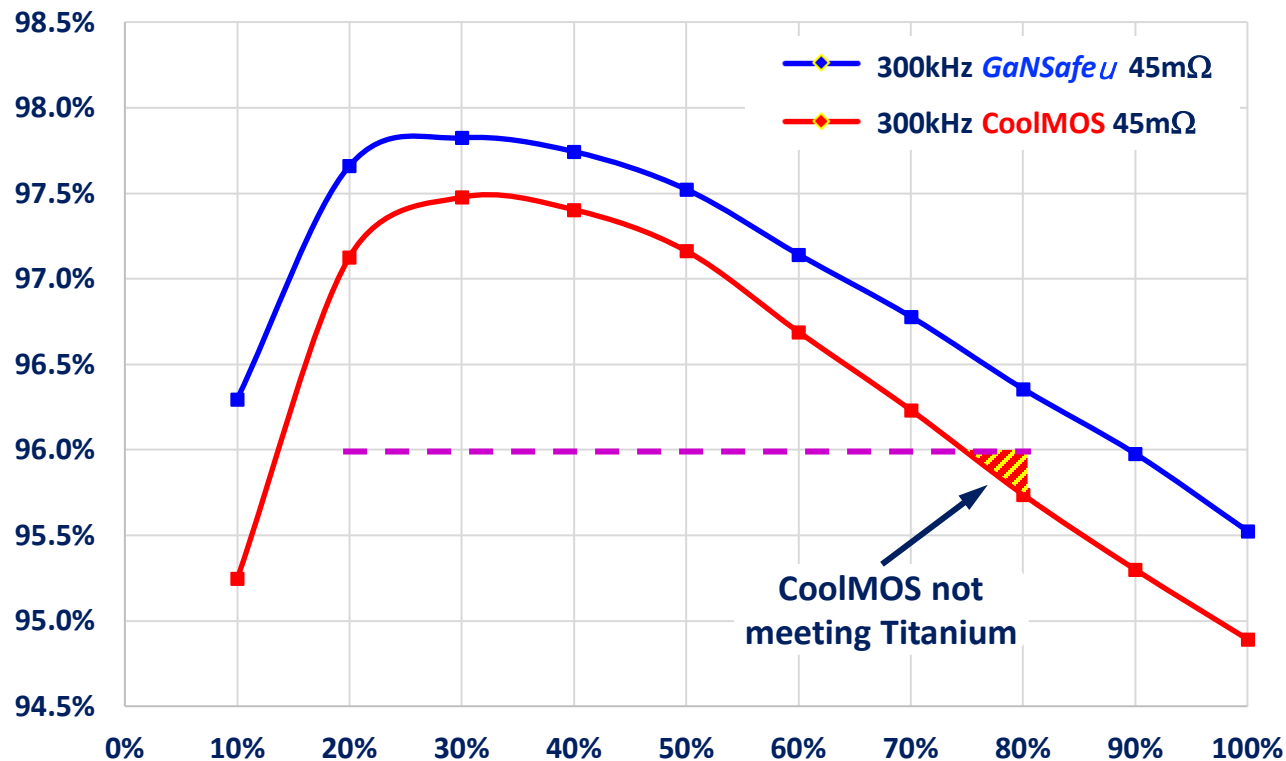
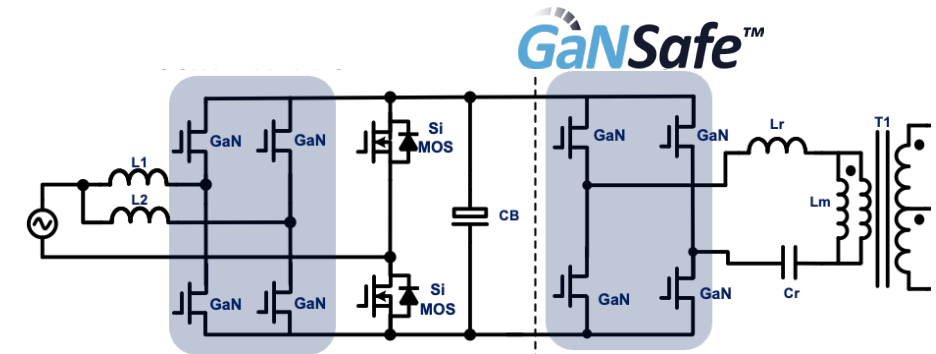
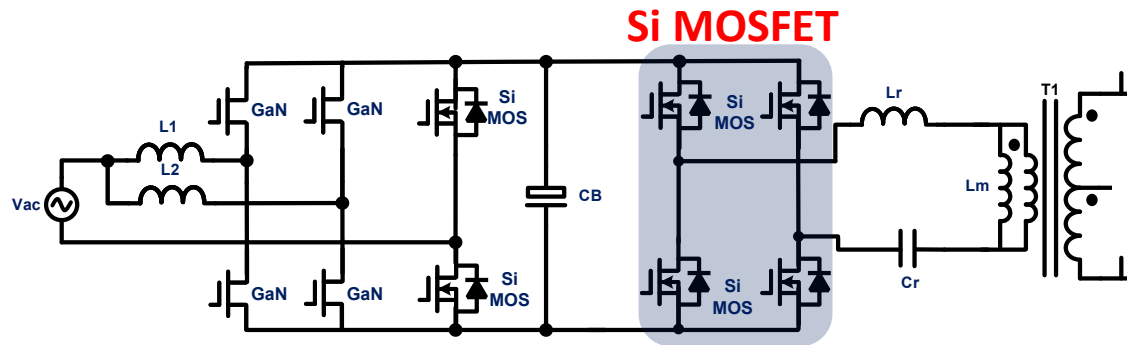


**GaNSafe™ +40% Hold-up**



**GaNSafe™ ~100W/in³**





- **GaNSafe™** meets Titanium with higher power density at 300kHz
- **CoolMOS** does not meet Titanium at 300kHz  $F_{sw}$  in LLC stage
- **GaNSafe™** meets EN55022 / CISPR22 Class A (CE and RE)



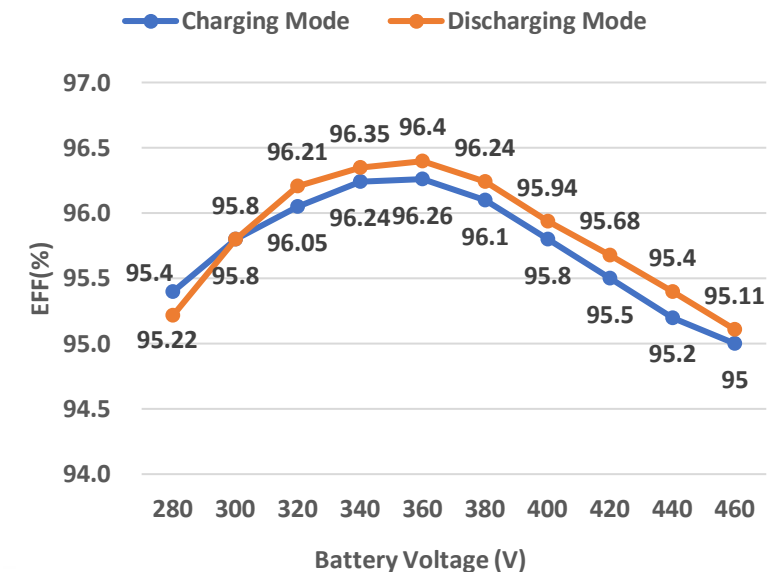
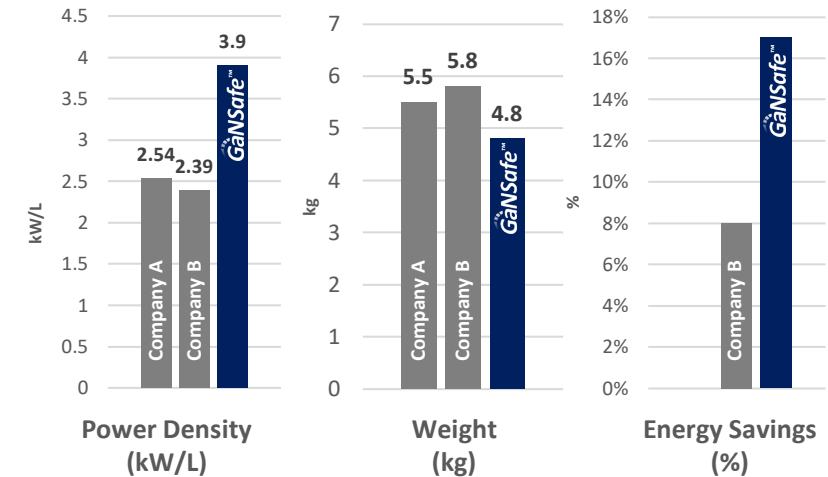
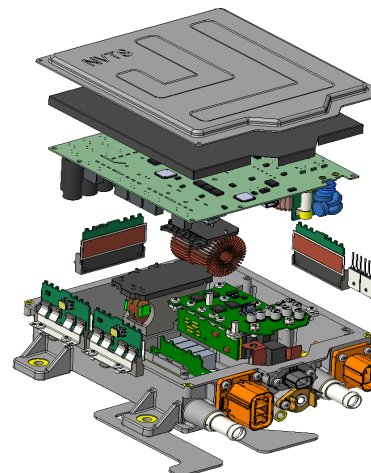
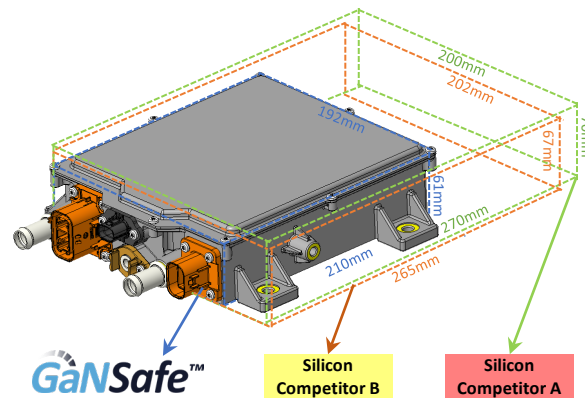
## Combination 6.6 kW OBC + 3 kW DC-DC:

- **AC Input:** 90~265 V<sub>AC</sub> up to 32 A
- **DC Output:** 470~860 V<sub>DC</sub>, full load
- **Power Output:** 6.6 kW charging, 6.0 kVA discharging
- **Efficiency:** ≥ 95% @ Full Load
- **DC-DC Output:** 9~16 V<sub>DC</sub>

## Mechanical:

- **Dimensions:** 210 x 192 x 61mm ( ≤ 2.5 litre)
- **Cooling:** -40 to +65°C (Cold Plate)
- **Communication:** IP 67, CAN Bus interface

**GaNSafe™**  
Power density +50%  
to 3.9 kW/litre







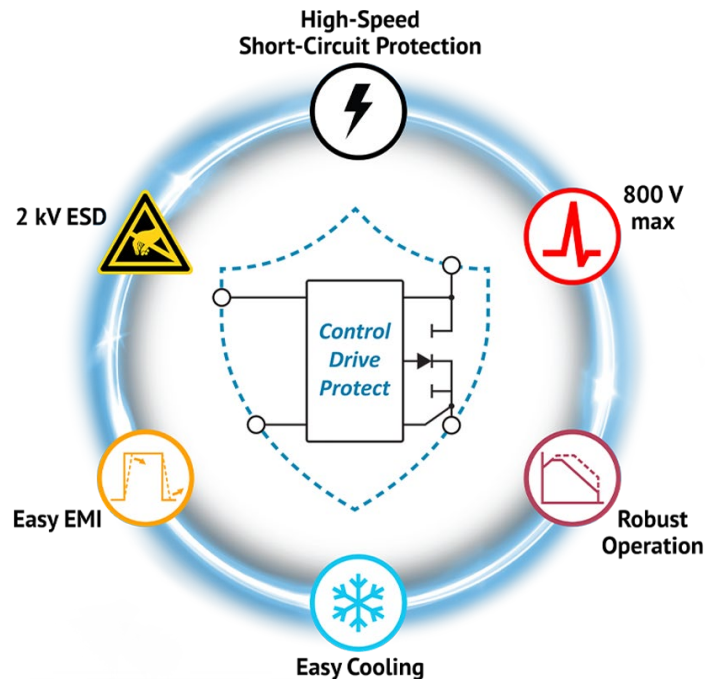
- Navitas is the industry leader in GaN

- **GaNFast™:**

- 100M+ shipped, 20-year warranty

- **GaNSafe™:**

- Most protected, most reliable, safest GaN power semi
- Benchmark efficiency, power density, reliability
- Robust, 4-pin TOLL
- Easy to use, fast time-to-market
- Demonstrated performance for AI, EV, Solar and more
- Strong customer pipeline
- ***Driving GaN into high power***



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